## ADC3421-Q1 Automotive, Quad-Channel, 12-Bit, 25-MSPS Analog-to-Digital Converter

## 1 Features

- AEC-Q100 Qualified for automotive applications
- Temperature grade $1:-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C} \mathrm{T}_{\mathrm{A}}$
- Quad channel
- 12-Bit resolution
- Single supply: 1.8 V
- Serial LVDS interface
- Flexible input clock buffer with divide-by-1, -2, -4
- $\operatorname{SNR}=71.1 \mathrm{dBFS}, \mathrm{SFDR}=90 \mathrm{dBc}$ at $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$
- Ultra-low power consumption:
- $44 \mathrm{~mW} / \mathrm{Ch}$ at 25 MSPS
- Channel isolation: 105 dB
- Internal dither and chopper
- Support for multichip synchronization


## 2 Applications

- Solid state LiDAR
- Motor control feedback
- Nondestructive testing
- Radar and smart antenna arrays
- Munitions guidance


## 3 Description

The ADC3421-Q1 is an automotive-grade, highlinearity, ultra-low power, quad-channel, 12-bit, 25MSPS analog-to-digital converter (ADC). The device is designed specifically to support demanding, high input frequency signals with large dynamic range requirements. An input clock divider gives more flexibility for system clock architecture design, and the SYSREF input enables complete system synchronization. The ADC3421-Q1 supports serial low-voltage differential signaling (LVDS) in order to reduce the number of interface lines, thus allowing for high system integration density. The serial LVDS interface is two-wire, where each ADC data are serialized and output over two LVDS pairs. An internal phase-locked loop (PLL) multiplies the incoming ADC sampling clock to derive the bit clock that is used to serialize the 12-bit output data from each channel. In addition to the serial data streams, the frame and bit clocks are also transmitted as LVDS outputs.
Device Information

| $\mathbf{1 1}$ |  |  |
| :---: | :---: | :---: |
| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
| ADC3421-Q1 | VQFNP $(56)$ | $8.00 \mathrm{~mm} \times 8.00 \mathrm{~mm}$ |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

Spectrum at $10-\mathrm{MHz}$ IF
SFDR $=90 \mathrm{dBc}$, $\mathrm{SNR}=71.2 \mathrm{dBFS}$, SINAD $=71.1 \mathrm{dBFS}$, THD $=89 \mathrm{dBC}$


## Table of Contents

1 Features ..... 1
2 Applications ..... 1
3 Description ..... 1
4 Revision History ..... 2
5 Pin Configuration and Functions ..... 3
6 Specifications ..... 5
6.1 Absolute Maximum Ratings ..... 5
6.2 ESD Ratings ..... 5
6.3 Recommended Operating Conditions ..... 5
6.4 Thermal Information ..... 6
6.5 Electrical Characteristics: General ..... 6
6.6 Electrical Characteristics: AC Performance ..... 7
6.7 Digital Characteristics ..... 9
6.8 Timing Requirements: General ..... 9
6.9 Timing Requirements: LVDS Output ..... 10
6.10 Typical Characteristics ..... 11
7 Parameter Measurement Information ..... 16
7.1 Timing Diagrams ..... 16
8 Detailed Description ..... 18
8.1 Overview ..... 18
8.2 Functional Block Diagram ..... 18
8.3 Feature Description ..... 19
8.4 Device Functional Modes ..... 23
8.5 Programming. ..... 26
8.6 Register Maps ..... 30
9 Applications and Implementation ..... 52
9.1 Application Information. ..... 52
9.2 Typical Applications ..... 53
10 Power Supply Recommendations ..... 55
11 Layout. ..... 56
11.1 Layout Guidelines ..... 56
11.2 Layout Example ..... 56
12 Device and Documentation Support ..... 57
12.1 Receiving Notification of Documentation Updates ..... 57
12.2 Support Resources ..... 57
12.3 Trademarks ..... 57
12.4 Electrostatic Discharge Caution. ..... 57
12.5 Glossary. ..... 57
13 Mechanical, Packaging, and Orderable Information ..... 57

## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.
Changes from Original (December 2019) to Revision A ..... Page

- Changed the Register Initialization section ..... 27
- Changed Figure 50 ..... 29
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## 5 Pin Configuration and Functions



Pin Functions

| PIN |  | I/O | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| NAME | NO. |  |  |
| AVDD | $\begin{gathered} 6,7,10,11,14, \\ 15,20,23,28,29, \\ 32,33,36 \end{gathered}$ | 1 | Analog 1.8-V power supply |
| CLKM | 21 | 1 | Negative differential clock input for the ADC |
| CLKP | 22 | 1 | Positive differential clock input for the ADC |
| DAOM | 4 | 0 | Negative serial LVDS output for wire-0 of channel A |
| DAOP | 3 | 0 | Positive serial LVDS output for wire-0 of channel A |
| DA1M | 2 | 0 | Negative serial LVDS output for wire-1 of channel A |
| DA1P | 1 | 0 | Positive serial LVDS output for wire-1 of channel A |
| DBOM | 56 | 0 | Negative serial LVDS output for wire-0 of channel B |
| DBOP | 55 | 0 | Positive serial LVDS output for wire-0 of channel B |
| DB1M | 54 | 0 | Negative serial LVDS output for wire-1 of channel B |
| DB1P | 53 | 0 | Positive serial LVDS output for wire-1 of channel B |
| DCOM | 46 | 0 | Negative serial LVDS output for wire-0 of channel C |
| DCOP | 45 | 0 | Positive serial LVDS output for wire-0 of channel C |
| DC1M | 44 | 0 | Negative serial LVDS output for wire-1 of channel C |
| DC1P | 43 | 0 | Positive serial LVDS output for wire-1 of channel C |
| DDOM | 42 | 0 | Negative serial LVDS output for wire-0 of channel D |
| DDOP | 41 | 0 | Positive serial LVDS output for wire-0 of channel D |
| DD1M | 40 | 0 | Negative serial LVDS output for wire-1 of channel D |
| DD1P | 39 | 0 | Positive serial LVDS output for wire-1 of channel D |
| DCLKM | 51 | 0 | Negative bit clock output |
| DCLKP | 50 | O | Positive bit clock output |
| DVDD | 5, 38, 47, 52 | 1 | Digital 1.8-V power supply |
| FCLKM | 49 | 0 | Negative frame clock output |
| FCLKP | 48 | O | Positive frame clock output |
| INAM | 8 | 1 | Negative differential analog input for channel A |
| INAP | 9 | 1 | Positive differential analog input for channel A |
| INBM | 13 | 1 | Negative differential analog input for channel B |
| INBP | 12 | 1 | Positive differential analog input for channel B |
| INCM | 30 | 1 | Negative differential analog input for channel C |
| INCP | 31 | I | Positive differential analog input for channel C |
| INDM | 35 | 1 | Negative differential analog input for channel D |
| INDP | 34 | 1 | Positive differential analog input for channel D |
| PDN | 37 | 1 | Power-down control. This pin can be configured using the SPI. This pin has an internal 150-k $\Omega$ pulldown resistor. |
| RESET | 24 | 1 | Hardware reset; active high. This pin has an internal 150-kת pulldown resistor. |
| SCLK | 16 | 1 |  |
| SDATA | 17 | 1 | Serial interface data input. This pin has an internal 150-k $\Omega$ pulldown resistor. |
| SDOUT | 19 | O | Serial interface data output |
| SEN | 18 | 1 | Serial interface enable; active low. <br> This pin has an internal $150-\mathrm{k} \Omega$ pullup resistor to AVDD. |
| SYSREFM | 26 | 1 | Negative external SYSREF input |
| SYSREFP | 25 | 1 | Positive external SYSREF input |
| VCM | 27 | O | Common-mode voltage for analog inputs |
| Thermal Pad | - | - | Connect thermal pad to ground. |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) ${ }^{(1)}$

|  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Analog supply voltage range, AVDD |  | -0.3 | 2.1 | V |
| Digital supply voltage range, DVDD |  | -0.3 | 2.1 | V |
| Voltage applied to input pins | INAP, INBP, INCP, INDP, INAM, INBM, INCM, INDM | -0.3 | $\min (1.9, \mathrm{AVDD}+0.3)$ | V |
|  | CLKP, CLKM | -0.3 | AVDD + 0.3 |  |
|  | SYSREFP, SYSREFM | -0.3 | AVDD + 0.3 |  |
|  | SCLK, SEN, SDATA, RESET, PDN | -0.3 | 3.9 |  |
| Temperature | Operating junction, $\mathrm{T}_{J}$ |  | 150 | 응 |
|  | Storage, $\mathrm{T}_{\text {stg }}$ | -65 | 150 |  |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

|  |  |  | VALUE | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {(ESD) }}$ | Electrostatic discharge | Human-body model (HBM), per AEC Q100-002 ${ }^{(1)}$ HBM ESD Classification Level 2 | $\pm 2000$ | V |
|  |  | Charged-device model (CDM), per AEC Q100-011 CDM ESD Classification Level C5 | $\pm 750$ |  |

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 6.3 Recommended Operating Conditions ${ }^{(1)}$

over operating free-air temperature range (unless otherwise noted)

|  |  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Suppli |  |  |  |  |  |  |
| AVDD | Analog supply voltage range |  | 1.7 | 1.8 | 1.9 | V |
| DVDD | Digital supply voltage range |  | 1.7 | 1.8 | 1.9 | V |
| Analog |  |  |  |  |  |  |
|  |  | For input frequencies < 450 MHz |  | 2 |  |  |
| VID | Diferential input volage | For input frequencies < 600 MHz |  | 1 |  | Pp |
| $\mathrm{V}_{\text {IC }}$ | Input common-mode voltage |  |  | 0.025 |  | V |
| Clock |  |  |  |  |  |  |
|  | Input clock frequency | Sampling clock frequency | $15^{(2)}$ |  | 25 | MSPS |
|  |  | Sine wave, ac-coupled | 0.2 | 1.5 |  |  |
|  | Input clock amplitude (differential) | LPECL, ac-coupled |  | 1.6 |  | $\mathrm{V}_{\mathrm{PP}}$ |
|  |  | LVDS, ac-coupled |  | 0.7 |  |  |
|  | Input clock duty cycle |  | 35\% | 50\% | 65\% |  |
|  | Input clock common-mode voltage |  |  | 0.95 |  | V |
| Digital | puts |  |  |  |  |  |
| Cload | Maximum external load capacitance from each output pin to GND |  |  | 3.3 |  | pF |
| $\mathrm{R}_{\text {LOAD }}$ | Single-ended load resistance |  |  | 100 |  | $\Omega$ |
| Tempe |  |  |  |  |  |  |
| $\mathrm{T}_{\mathrm{J}}$ | Operating Junction Temperature |  | -40 |  | 125 | ${ }^{\circ} \mathrm{C}$ |

(1) After power-up, use only the RESET pin to reset the device for the first time; see the Register Initialization section for details.
(2) See Table 1 for details.

## ADC3421-Q1

### 6.4 Thermal Information

| THERMAL METRIC ${ }^{(1)}$ |  | $\begin{aligned} & \text { ADC3421-Q1 } \\ & \hline \text { RWE (VQFNP) } \end{aligned}$ | UNIT |
| :---: | :---: | :---: | :---: |
|  |  |  |  |
|  |  | 56 PINS |  |
| $\mathrm{R}_{\text {өJA }}$ | Junction-to-ambient thermal resistance | 20.3 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\text {өJC }}$ (top) | Junction-to-case (top) thermal resistance | 8.8 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\text {өJB }}$ | Junction-to-board thermal resistance | 5.6 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\psi_{\text {JT }}$ | Junction-to-top characterization parameter | 0.1 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\psi_{\text {JB }}$ | Junction-to-board characterization parameter | 5.6 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\theta \mathrm{JCC} \text { (bot) }}$ | Junction-to-case (bottom) thermal resistance | 0.7 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report.

### 6.5 Electrical Characteristics: General

Typical values are over the operating free-air temperature range, at $T_{A}=25^{\circ} \mathrm{C}$, full temperature range is $\mathrm{T}_{\text {MIN }}=-40^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}$ $=125^{\circ} \mathrm{C}$, maximum sampling rate, $50 \%$ clock duty cycle, $\mathrm{AVDD}=\mathrm{DVDD}=1.8 \mathrm{~V}$, and $-1-\mathrm{dBFS}$ differential input, unless otherwise noted.

| PARAMETER |  | TEST CONDITIONS |  | MIN TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | ADC clock frequency |  |  |  | 25 | MSPS |
|  | Resolution |  |  | 12 |  | Bits |
|  | 1.8-V analog supply current |  |  | 54 | 71 | mA |
|  | 1.8-V digital supply current |  |  | 45 | 71 | mA |
|  | Total power dissipation |  |  | 177 | 240 | mW |
|  | Global power-down dissipation |  |  | 5 | 17 | mW |
|  | Standby power-down dissipation |  |  | 34 | 75 | mW |
| Analog Input |  |  |  |  |  |  |
|  | Differential input full-scale |  |  | 2.0 |  | $V_{\text {PP }}$ |
| $\mathrm{r}_{\mathrm{i}}$ | Input resistance | Differential at d |  | 6.6 |  | $\mathrm{k} \Omega$ |
| $\mathrm{c}_{\mathrm{i}}$ | Input capacitance | Differential at d |  | 3.7 |  | pF |
| $\mathrm{V}_{\mathrm{OC}(\mathrm{VCM})}$ | VCM common-mode voltage output |  |  | 0.95 |  | V |
|  | VCM output current capability |  |  | 10 |  | mA |
|  | Input common-mode current | Per analog input pin |  | 1.5 |  | $\mu \mathrm{A} / \mathrm{MSPS}$ |
|  | Analog input bandwidth (3 dB) | $50-\Omega$ differential source driving $50-\Omega$ termination across INP and INM |  | 540 |  | MHz |
| DC accuracy |  |  |  |  |  |  |
| $\mathrm{E}_{0}$ | Offset error |  |  | -25 | 25 | mV |
| $\alpha_{E O}$ | Temperature coefficient of offset error |  |  | $\pm 0.024$ |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{E}_{\mathrm{G}(\mathrm{REF})}$ | Gain error as a result of internal reference inaccuracy alone |  |  | -2 | 2 | \%FS |
| $\mathrm{E}_{\mathrm{G}(\mathrm{CHAN})}$ | Gain error of channel alone |  |  | -2 |  | \%FS |
| $\alpha_{\text {(EGCHAN) }}$ | Temperature coefficient of $\mathrm{E}_{\mathrm{G}(\mathrm{CHAN})}$ |  |  | $\pm 0.008$ |  | $\Delta \%$ FS/Ch |
| Channel-to-channel Isolation |  |  |  |  |  |  |
|  | Crosstalk ${ }^{(1)}$ | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ | Near channel | 105 |  | dB |
|  |  |  | Far channel | 105 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ | Near channel | 95 |  |  |
|  |  |  | Far channel | 105 |  |  |
|  |  | $\mathrm{f}_{\mathrm{I}}=200 \mathrm{MHz}$ | Near channel | 94 |  |  |
|  |  |  | Far channel | 105 |  |  |
|  |  | $\mathrm{f}_{\mathrm{N}}=230 \mathrm{MHz}$ | Near channel | 92 |  |  |
|  |  |  | Far channel | 105 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=300 \mathrm{MHz}$ | Near channel | 85 |  |  |
|  |  |  | Far channel | 105 |  |  |

(1) Crosstalk is measured with a $-1-\mathrm{dBFS}$ input signal on the aggressor channel and no input on the victim channel.

### 6.6 Electrical Characteristics: AC Performance

Typical values are over the operating free-air temperature range, at $T_{A}=25^{\circ} \mathrm{C}$, full temperature range is $\mathrm{T}_{\mathrm{MIN}}=-40^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}$ $=125^{\circ} \mathrm{C}, \mathrm{ADC}$ sampling rate $=25 \mathrm{MSPS}, 50 \%$ clock duty cycle, $\mathrm{AVDD}=\mathrm{DVDD}=1.8 \mathrm{~V}$, and $-1-\mathrm{dBFS}$ differential input, unless otherwise noted.

| PARAMETER |  | TEST CONDITIONS | DITHER ON |  | DITHER OFF |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP MAX | MIN TYP | MAX |  |
| SNR | Signal-to-noise ratio (from $1-\mathrm{MHz}$ offset) |  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ |  | 70.9 | 71.1 |  | dBFS |
|  |  | $\mathrm{f}_{\mathrm{IN}}=20 \mathrm{MHz}$ | 68.9 | 70.7 | 70.9 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ |  | 70.4 | 70.6 |  |  |  |
|  |  | $\mathrm{fiN}_{\text {IN }}=100 \mathrm{MHz}$ |  | 70.3 | 70.5 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=170 \mathrm{MHz}$ |  | 69.7 | 69.9 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=230 \mathrm{MHz}$ |  | 68.9 | 69.1 |  |  |  |
|  | Signal-to-noise ratio (full Nyquist band) | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ |  | 70.2 | 70.5 |  | dBFS |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=20 \mathrm{MHz}$ |  | 70.1 | 70.3 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ |  | 69.8 | 70.0 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ |  | 69.6 | 69.8 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=170 \mathrm{MHz}$ |  | 69.2 | 69.3 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=230 \mathrm{MHz}$ |  | 68.3 | 68.5 |  |  |  |
| NSD ${ }^{(1)}$ | Noise spectral density (averaged across Nyquist zone) | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ |  | -141.5 | -141.7 |  | dBFS/Hz |  |
|  |  | $\mathrm{f}_{\mathrm{N}}=20 \mathrm{MHz}$ |  | -141.3 -139.5 | -141.5 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{N}}=70 \mathrm{MHz}$ |  | -141.0 | -141.2 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ |  | -140.9 | -141.1 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=170 \mathrm{MHz}$ |  | -140.3 | -140.5 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=230 \mathrm{MHz}$ |  | -139.5 | -139.7 |  |  |  |
| SINAD ${ }^{(1)}$ | Signal-to-noise and distortion ratio | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ |  | 71 | 71.1 |  | dBFS |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=20 \mathrm{MHz}$ | 67.9 | 70.8 | 70.9 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ |  | 69.5 | 70 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ |  | 70.5 | 70.7 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=170 \mathrm{MHz}$ |  | 69.6 | 69.8 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=230 \mathrm{MHz}$ |  | 68.7 | 68.7 |  |  |  |
| ENOB ${ }^{(1)}$ | Effective number of bits | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ |  | 11.5 | 11.5 |  | Bits |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=20 \mathrm{MHz}$ | 11 | 11.4 | 11.4 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ |  | 11.4 | 11.4 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ |  | 11.4 | 11.4 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=170 \mathrm{MHz}$ |  | 11.3 | 11.3 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=230 \mathrm{MHz}$ |  | 11.1 | 11.1 |  |  |  |
| SFDR | Spurious-free dynamic range | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ |  | 93 | 90 |  | dBc |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=20 \mathrm{MHz}$ | 84 | 91 | 85 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ |  | 93 | 88 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ |  | 85 | 82 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=170 \mathrm{MHz}$ |  | 86 | 85 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=230 \mathrm{MHz}$ |  | 82 | 82 |  |  |  |

(1) Reported from a $1-\mathrm{MHz}$ offset.

## Electrical Characteristics: AC Performance (continued)

Typical values are over the operating free-air temperature range, at $T_{A}=25^{\circ} \mathrm{C}$, full temperature range is $\mathrm{T}_{\mathrm{MIN}}=-40^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}$ $=125^{\circ} \mathrm{C}, \mathrm{ADC}$ sampling rate $=25 \mathrm{MSPS}, 50 \%$ clock duty cycle, $\mathrm{AVDD}=\mathrm{DVDD}=1.8 \mathrm{~V}$, and $-1-\mathrm{dBFS}$ differential input, unless otherwise noted.

| PARAMETER |  | TEST CONDITIONS | DITHER ON |  |  | DITHER OFF |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| HD2 | Second-order harmonic distortion |  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ |  | 93 |  |  | 92 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=20 \mathrm{MHz}$ | 83 | 100 |  |  | 94 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ |  | 93 |  |  | 92 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ |  | 94 |  |  | 93 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=170 \mathrm{MHz}$ |  | 86 |  |  | 85 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=230 \mathrm{MHz}$ |  | 86 |  |  | 82 |  |  |  |
| HD3 | Third-order harmonic distortion | $\mathrm{f}_{\mathrm{N}}=10 \mathrm{MHz}$ |  | 96 |  |  | 90 |  | dBc |  |
|  |  | $\mathrm{f}_{\mathrm{N}}=20 \mathrm{MHz}$ | 82 | 91 |  |  | 85 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ |  | 93 |  |  | 88 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ |  | 85 |  |  | 82 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=170 \mathrm{MHz}$ |  | 89 |  |  | 89 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=230 \mathrm{MHz}$ |  | 82 |  |  | 82 |  |  |  |
| Non HD2, HD3 | Spurious-free dynamic range (excluding HD2, HD3) | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ |  | 99 |  |  | 92 |  | dBc |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=20 \mathrm{MHz}$ | 86 | 98 |  |  | 91 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ |  | 96 |  |  | 92 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ |  | 95 |  |  | 93 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=170 \mathrm{MHz}$ |  | 92 |  |  | 90 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=230 \mathrm{MHz}$ |  | 97 |  |  | 91 |  |  |  |
| THD | Total harmonic distortion | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$ |  | 90 |  |  | 86 |  | dBc |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=20 \mathrm{MHz}$ | 78 | 90 |  |  | 83 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=70 \mathrm{MHz}$ |  | 89 |  |  | 85 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ |  | 84 |  |  | 80 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=170 \mathrm{MHz}$ |  | 84 |  |  | 83 |  |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=230 \mathrm{MHz}$ |  | 80 |  |  | 79 |  |  |  |
| IMD3 | Two-tone, third-order intermodulation distortion | $\begin{aligned} & \mathrm{f}_{\mathrm{IN} 1}=45 \mathrm{MHz}, \\ & \mathrm{f}_{\mathrm{IN} 2}=50 \mathrm{MHz} \end{aligned}$ |  | -98 |  |  | -98 |  | dBFS |  |
|  |  | $\begin{aligned} & \mathrm{f}_{\mathrm{IN} 1}=185 \mathrm{MHz}, \\ & \mathrm{f}_{\mathrm{IN} 2}=190 \mathrm{MHz} \end{aligned}$ |  | -91 |  |  | -91 |  |  |  |

### 6.7 Digital Characteristics

The dc specifications refer to the condition where the digital outputs are not switching, but are permanently at a valid logic level 0 or $1 . \mathrm{AVDD}=\mathrm{DVDD}=1.8 \mathrm{~V}$, and $-1-\mathrm{dBFS}$ differential input, unless otherwise noted.

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Digital Inputs (RESET, SCLK, SDATA, SEN, PDN) |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage |  | All digital inputs support 1.8-V and 3.3-V CMOS logic levels | 1.3 |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  | All digital inputs support $1.8-\mathrm{V}$ and 3.3-V CMOS logic levels |  |  | 0.4 | V |
| $\mathrm{I}_{\mathrm{H}}$ | High-level input current | $\begin{aligned} & \text { RESET, SDATA, SCLK, } \\ & \text { PDN } \end{aligned}$ | $\mathrm{V}_{\text {HIGH }}=1.8 \mathrm{~V}$ |  | 10 |  | $\mu \mathrm{A}$ |
|  |  | SEN ${ }^{(1)}$ | $\mathrm{V}_{\text {HIGH }}=1.8 \mathrm{~V}$ |  | 0 |  | $\mu \mathrm{A}$ |
| $1 / L$ | Low-level input current | RESET, SDATA, SCLK, PDN | $\mathrm{V}_{\text {Low }}=0 \mathrm{~V}$ |  | 0 |  | $\mu \mathrm{A}$ |
|  |  | SEN | $\mathrm{V}_{\text {Low }}=0 \mathrm{~V}$ |  | 10 |  | $\mu \mathrm{A}$ |
| DigitaL Inputs (SYSREFP, SYSREFM) |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage |  |  |  | 1.3 |  | V |
| $\mathrm{V}_{\mathrm{IL}}$ | Low-level input voltage |  |  |  | 0.5 |  | V |
|  | Common-mode voltage for SYSREF |  |  |  | 0.9 |  | V |
| Digital Outputs (CMOS Interface, SDOUT) |  |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  |  | DVDD - 0.1 | DVDD |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage |  |  |  | 0 | 0.1 | V |
| Digital Outputs (LVDS Interface) |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {ODH }}$ | High-level output differential voltage |  | With an external 100- $\Omega$ termination | 280 | 350 | 460 | mV |
| $\mathrm{V}_{\text {ODL }}$ | Low-level output differential voltage |  | With an external 100- $\Omega$ termination | -460 | -350 | -280 | mV |
| $V_{\text {OCM }}$ | Output common-mode voltage |  |  |  | 1.05 |  | V |

(1) SEN has an internal $150-\mathrm{k} \Omega$ pullup resistor to AVDD. SPI pins (SEN, SCLK, SDATA) can be driven by 1.8 V or 3.3 V CMOS buffers.

### 6.8 Timing Requirements: General

Typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{AVDD}=\mathrm{DVDD}=1.8 \mathrm{~V}$, and $-1-\mathrm{dBFS}$ differential input, unless otherwise noted. Minimum and maximum values are across the full temperature range: $\mathrm{T}_{\mathrm{MIN}}=-40^{\circ} \mathrm{C}$ to $\mathrm{T}_{\mathrm{MAX}}=125^{\circ} \mathrm{C}$.

|  |  |  | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{A}}$ | Aperture delay |  | 1.24 | 1.44 | 1.64 | ns |
|  | Aperture delay matching between two channels of the same device |  |  | $\pm 70$ |  | ps |
|  | Aperture delay variation between two devices at same temperature and supply voltage |  |  | $\pm 150$ |  | ps |
| $\mathrm{t}_{\mathrm{J}}$ | Aperture jitter |  |  | 130 |  | $\mathrm{f}_{\mathrm{S}} \mathrm{rms}$ |
|  | Wake-up time: | Time to valid data after exiting standby power-down mode |  | 35 | 200 | $\mu \mathrm{s}$ |
|  |  | Time to valid data after exiting global power-down mode (in this mode, both channels power down) |  | 85 | 450 | $\mu \mathrm{s}$ |
|  | ADC latency ${ }^{(1)}$ : | 2-wire mode (default) |  | 9 |  | Clock cycles |
|  |  | 1-wire mode |  | 8 |  | Clock cycles |
| tSU_SYSREF | SYSREF reference time: | Setup time for SYSREF referenced to input clock rising edge | 1000 |  |  | ps |
| $t_{\text {H_SYSREF }}$ |  | Hold time for SYSREF referenced to input clock rising edge | 100 |  |  | ps |

(1) Overall latency $=$ ADC latency $+t_{\text {PDI }}$.

### 6.9 Timing Requirements: LVDS Output ${ }^{(1)(2)}$

Typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, AVDD $=$ DVDD $=1.8 \mathrm{~V}$, and $-1-\mathrm{dBFS}$ differential input, 6 x Serialization ( 2 -Wire Mode), $C_{\text {LOAD }}=3.3 \mathrm{pF}^{(3)}$, and $\mathrm{R}_{\text {LOAD }}=100 \Omega^{(4)}$, unless otherwise noted.. Minimum and maximum values are across the full temperature range: $\mathrm{T}_{\text {MIN }}=-40^{\circ} \mathrm{C}$ to $\mathrm{T}_{\text {MAX }}=125^{\circ} \mathrm{C}$.

|  |  |  | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Data setup time: data valid to zero-crossing of differential | 1-wire mode | 1.3 | 1.48 |  |  |
|  | output clock (CLKOUTP - CLKOUTM) ${ }^{(5)(6)}$ | 2-wire mode | 2.61 | 3.06 |  | ns |
|  | Data hold time: zero-crossing of differential output clock | 1-wire mode | 1.32 | 1.57 |  | ns |
| tHO | (CLKOUTP - CLKOUTM) to data becoming invalid ${ }^{(5)(6)}$ | 2-wire mode | 2.75 | 3.12 |  | ns |
|  | Clock propagation delay: input clock falling edge cross-over to | 1-wire mode |  | $+t_{\text {DELAY }}$ |  | ns |
| $\mathrm{t}_{\text {PDI }}$ | frame clock rising edge cross-over <br> (15 MSPS < sampling frequency < 25 MSPS) | 2-wire mode |  | + t DELAY |  | ns |
| $t_{\text {DELAY }}$ | Delay time |  | 3 | 4.5 | 5.9 | ns |
|  | LVDS bit clock duty cycle: duty cycle of differential clock (CLKOUTP - CLKOUTM) |  |  | 49\% |  |  |
| $t_{\text {FALL }}$, $t_{\text {RISE }}$ | Data fall time, data rise time: rise time measured from -100 mV 15 MSPS $\leq$ Sampling frequency $\leq 25$ MSPS | $\text { V to } 100 \mathrm{mV} \text {, }$ |  | 0.11 |  | ns |
| $t_{\text {CLKRISE }}$, $t_{\text {CLKFALL }}$ | Output clock rise time, output clock fall time: rise time measure -100 mV to 100 mV , 15 MSPS $\leq$ Sampling frequency $\leq 25 \mathrm{MS}$ | d from PS |  | 0.11 |  | ns |

(1) Measurements are done with a transmission line of a $100-\Omega$ characteristic impedance between the device and load. Setup and hold time specifications take into account the effect of jitter on the output data and clock.
(2) Timing parameters are ensured by design and characterization and are not tested in production.
(3) $C_{\text {LOAD }}$ is the effective external single-ended load capacitance between each output pin and ground.
(4) $R_{\text {LOAD }}$ is the differential load resistance between the LVDS output pair.
(5) Data valid refers to a logic high of 100 mV and a logic low of -100 mV .
(6) Write relevant register settings as mentioned in Table 22.

ADC3421-Q1
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### 6.10 Typical Characteristics

typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, ADC sampling rate $=25 \mathrm{MSPS}, 50 \%$ clock duty cycle, $\mathrm{AVDD}=1.8 \mathrm{~V}, \mathrm{DVDD}=1.8 \mathrm{~V},-1-$ dBFS differential input, $2-\mathrm{V}_{\mathrm{PP}}$ full-scale, 32k-point FFT, chopper disabled, and SNR reported with a $1-\mathrm{MHz}$ offset from dc when chopper is disabled and from $\mathrm{f}_{\mathrm{S}} / 2$ when chopper is enabled (unless otherwise noted).


Figure 3. FFT for 70-MHz Input Signal (Dither On)


SFDR $=87 \mathrm{dBc}, \mathrm{SNR}=69.8 \mathrm{dBFS}$, SINAD $=69.7 \mathrm{dBFS}$, $\mathrm{THD}=85 \mathrm{dBc}, \mathrm{HD} 2=90 \mathrm{dBc}, \mathrm{HD} 3=87 \mathrm{dBc}$

Figure 5. FFT for 170-MHz Input Signal (Dither On)


SFDR $=90 \mathrm{dBc}, \mathrm{SNR}=71.2 \mathrm{dBFS}$, SINAD $=71.1 \mathrm{dBFS}$, $\mathrm{THD}=89 \mathrm{dBc}, \mathrm{HD} 2=90 \mathrm{dBc}, \mathrm{HD} 3=106 \mathrm{dBc}$

Figure 2. FFT for 10-MHz Input Signal (Dither Off)


SFDR $=91 \mathrm{dBc}$, SNR $=70.7 \mathrm{dBFS}$, SINAD $=70.6 \mathrm{dBFS}$, $\mathrm{THD}=88 \mathrm{dBc}, \mathrm{HD} 2=91 \mathrm{dBc}, \mathrm{HD} 3=101 \mathrm{dBc}$

Figure 4. FFT for 70-MHz Input Signal (Dither Off)


SFDR $=85 \mathrm{dBc}$, SNR $=70 \mathrm{dBFS}$, SINAD $=69.8 \mathrm{dBFS}$, $\mathrm{THD}=86 \mathrm{dBc}, \mathrm{HD} 2=85 \mathrm{dBc}, \mathrm{HD} 3=92 \mathrm{dBc}$

Figure 6. FFT for 170-MHz Input Signal (Dither Off)

## Typical Characteristics (continued)

typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, ADC sampling rate $=25 \mathrm{MSPS}, 50 \%$ clock duty cycle, $\mathrm{AVDD}=1.8 \mathrm{~V}$, $\mathrm{DVDD}=1.8 \mathrm{~V},-1-$ dBFS differential input, $2-\mathrm{V}_{\mathrm{PP}}$ full-scale, 32k-point FFT, chopper disabled, and SNR reported with a $1-\mathrm{MHz}$ offset from dc when chopper is disabled and from $\mathrm{f}_{\mathrm{S}} / 2$ when chopper is enabled (unless otherwise noted).


SFDR $=77 \mathrm{dBc}, \mathrm{SNR}=68.2 \mathrm{dBFS}, \mathrm{SINAD}=67.7 \mathrm{dBFS}$, THD $=75 \mathrm{dBc}, \mathrm{HD} 2=77 \mathrm{dBc}, \mathrm{HD} 3=83 \mathrm{dBc}$

Figure 7. FFT for 270-MHz Input Signal (Dither On)


SFDR $=67 \mathrm{dBc}, \mathrm{SNR}=66.4 \mathrm{dBFS}, \mathrm{SINAD}=66.4 \mathrm{dBFS}$, THD $=93 \mathrm{dBc}$, HD2 $=67 \mathrm{dBc}, \mathrm{HD} 3=88 \mathrm{dBc}$

Figure 9. FFT for 450-MHz Input Signal (Dither On)

$\mathrm{f}_{\mathrm{IN} 1}=46 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN} 2}=50 \mathrm{MHz}, \mathrm{IMD3}=90$,
each tone at $=-7 \mathrm{dBFS}$
Figure 11. FFT for Two-Tone Input Signal $(-7 \mathrm{dBFS}$ at $\mathbf{4 6 ~ M H z}$ and 50 MHz )


SFDR $=75 \mathrm{dBc}, \mathrm{SNR}=68.4 \mathrm{dBFS}, \mathrm{SINAD}=67.5 \mathrm{dBFS}$, THD $=74 \mathrm{dBc}, \mathrm{HD} 2=75 \mathrm{dBc}, \mathrm{HD} 3=80 \mathrm{dBc}$

Figure 8. FFT for 270-MHz Input Signal (Dither Off)


SFDR $=66 \mathrm{dBc}, \mathrm{SNR}=66.5 \mathrm{dBFS}, \mathrm{SINAD}=66.5 \mathrm{dBFS}$, THD $=87 \mathrm{dBc}, \mathrm{HD} 2=66 \mathrm{dBc}, \mathrm{HD} 3=93 \mathrm{dBc}$

Figure 10. FFT for $450-\mathrm{MHz}$ Input Signal (Dither Off)

$\mathrm{f}_{\mathrm{IN} 1}=46 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN} 2}=50 \mathrm{MHz}, \mathrm{IMD3}=105$,
each tone at $=-36 \mathrm{dBFS}$
Figure 12. FFT for Two-Tone Input Signal $(-36 \mathrm{dBFS}$ at $\mathbf{4 6} \mathbf{~ M H z}$ and 50 MHz )

## Typical Characteristics (continued)

typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, ADC sampling rate $=25 \mathrm{MSPS}, 50 \%$ clock duty cycle, $\mathrm{AVDD}=1.8 \mathrm{~V}, \mathrm{DVDD}=1.8 \mathrm{~V},-1-$ dBFS differential input, $2-\mathrm{V}_{\mathrm{PP}}$ full-scale, 32k-point FFT, chopper disabled, and SNR reported with a $1-\mathrm{MHz}$ offset from dc when chopper is disabled and from $\mathrm{f}_{\mathrm{S}} / 2$ when chopper is enabled (unless otherwise noted).

$\mathrm{f}_{\mathrm{IN} 1}=184.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN} 2}=189.5 \mathrm{MHz}, \mathrm{IMD} 3=91$, each tone at $=-7 \mathrm{dBFS}$

Figure 13. FFT for Two-Tone Input Signal ( -7 dBFS at 185 MHz and 190 MHz )


Figure 15. Intermodulation Distortion vs Input Amplitude ( 46 MHz and 50 MHz )


Figure 17. Signal-to-Noise Ratio vs Input Frequency

$\mathrm{f}_{\mathrm{IN} 1}=184.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN} 2}=189.5 \mathrm{MHz}, \operatorname{IMD} 3=98 \mathrm{dBFS}$, each tone at -36 dBFS

Figure 14. FFT for Two-Tone Input Signal ( -36 dBFS at 185 MHz and 190 MHz )


Figure 16. Intermodulation Distortion vs Input Amplitude ( 185 MHz and 190 MHz )


Figure 18. Spurious-Free Dynamic Range vs Input Frequency

## Typical Characteristics (continued)

typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, ADC sampling rate $=25 \mathrm{MSPS}, 50 \%$ clock duty cycle, $\mathrm{AVDD}=1.8 \mathrm{~V}$, $\mathrm{DVDD}=1.8 \mathrm{~V},-1-$ dBFS differential input, $2-\mathrm{V}_{\mathrm{PP}}$ full-scale, 32k-point FFT, chopper disabled, and SNR reported with a $1-\mathrm{MHz}$ offset from dc when chopper is disabled and from $\mathrm{f}_{\mathrm{S}} / 2$ when chopper is enabled (unless otherwise noted).


Figure 19. Performance vs Input Amplitude ( $\mathbf{3 0} \mathbf{~ M H z \text { ) }}$


Figure 21. Performance vs Input Common-Mode Voltage ( 30 MHz )


Figure 23. Spurious-Free Dynamic Range vs AVDD Supply and Temperature ( $\mathbf{3 0} \mathbf{~ M H z )}$


Figure 20. Performance vs Input Amplitude ( $170 \mathbf{~ M H z )}$


Figure 22. Performance vs Input Common-Mode Voltage ( 170 MHz )


Figure 24. Signal-to-Noise Ratio vs AVDD Supply and Temperature ( 30 MHz )

## Typical Characteristics (continued)

typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{ADC}$ sampling rate $=25 \mathrm{MSPS}, 50 \%$ clock duty cycle, $\mathrm{AVDD}=1.8 \mathrm{~V}, \mathrm{DVDD}=1.8 \mathrm{~V},-1-$ dBFS differential input, $2-\mathrm{V}_{\mathrm{PP}}$ full-scale, 32k-point FFT, chopper disabled, and SNR reported with a $1-\mathrm{MHz}$ offset from dc when chopper is disabled and from $\mathrm{f}_{\mathrm{S}} / 2$ when chopper is enabled (unless otherwise noted).


Figure 25. Spurious-Free Dynamic Range vs DVDD Supply and Temperature ( $\mathbf{3 0} \mathbf{~ M H z \text { ) }}$


Figure 27. Performance vs Clock Amplitude ( $\mathbf{4 0} \mathbf{~ M H z )}$


Figure 29. Performance vs Clock Duty Cycle (30 MHz)


Figure 26. Signal-to-Noise Ratio vs DVDD Supply and Temperature ( $\mathbf{3 0} \mathbf{~ M H z \text { ) }}$



Figure 28. Performance vs Clock Amplitude ( 150 MHz )


Figure 30. Performance vs Clock Duty Cycle (150 MHz)

## Typical Characteristics (continued)

typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, ADC sampling rate $=25 \mathrm{MSPS}, 50 \%$ clock duty cycle, $\mathrm{AVDD}=1.8 \mathrm{~V}$, $\mathrm{DVDD}=1.8 \mathrm{~V},-1-$ dBFS differential input, $2-\mathrm{V}_{\mathrm{PP}}$ full-scale, 32k-point FFT, chopper disabled, and SNR reported with a $1-\mathrm{MHz}$ offset from dc when chopper is disabled and from $\mathrm{f}_{\mathrm{S}} / 2$ when chopper is enabled (unless otherwise noted).


Figure 31. Integral Nonlinearity for a $\mathbf{2 0} \mathbf{- M H z}$ Input


Figure 32. Differential Nonlinearity for a 20-MHz Input

## 7 Parameter Measurement Information

### 7.1 Timing Diagrams


(1) With an external $100-\Omega$ termination.

Figure 33. Serial LVDS Output Voltage Levels

Timing Diagrams (continued)


Figure 34. Output Timing Diagram


Figure 35. Setup and Hold Time

## 8 Detailed Description

### 8.1 Overview

The ADC3421-Q1 is an automotive-grade, high-linearity, ultra-low power, quad-channel, 12-bit, 25-MSPS analog-to-digital converter (ADC). The device is designed specifically to support demanding, high input frequency signals with large dynamic range requirements. An input clock divider gives more flexibility for system clock architecture design, and the SYSREF input enables complete system synchronization. The ADC3421-Q1 supports a serial low-voltage differential signaling (LVDS) interface in order to reduce the number of interface lines, thus allowing for high system integration density. The serial LVDS interface is two-wire, where each ADC data are serialized and output over two LVDS pairs. An internal phase-locked loop (PLL) multiplies the incoming ADC sampling clock to derive the bit clock that is used to serialize the 12-bit output data from each channel. In addition to the serial data streams, the frame and bit clocks are also transmitted as LVDS outputs.

### 8.2 Functional Block Diagram



### 8.3 Feature Description

### 8.3.1 Analog Inputs

The ADC3421-Q1 analog signal inputs are designed to be driven differentially. Each input pin (INP, INM) must swing symmetrically between (VCM +0.5 V ) and (VCM -0.5 V ), resulting in a $2-\mathrm{V}_{\mathrm{PP}}$ (default) differential input swing. The input sampling circuit has a $3-\mathrm{dB}$ bandwidth that extends up to 540 MHz ( $50-\Omega$ source driving $50-\Omega$ termination between INP and INM).

### 8.3.2 Clock Input

The device clock inputs can be driven differentially (sine, LVPECL, or LVDS) or single-ended (LVCMOS), with little or no difference in performance between them. The common-mode voltage of the clock inputs is set to 0.95 V using internal $5-\mathrm{k} \Omega$ resistors. The self-bias clock inputs of the ADC3421-Q1 can be driven by the transformer-coupled, sine-wave clock source or by the ac-coupled, LVPECL and LVDS clock sources, as shown in Figure 36, Figure 37, and Figure 38. See Figure 39 for details regarding the internal clock buffer.


NOTE: $R_{T}=$ termination resistor, if necessary.
Figure 36. Differential Sine-Wave Clock Driving Circuit


Figure 37. LVDS Clock Driving Circuit


Figure 38. LVPECL Clock Driving Circuit


NOTE: $\mathrm{C}_{\mathrm{EQ}}$ is 1 pF to 3 pF and is the equivalent input capacitance of the clock buffer.
Figure 39. Internal Clock Buffer
A single-ended CMOS clock can be ac-coupled to the CLKP input, with CLKM connected to ground with a $0.1-\mu \mathrm{F}$ capacitor, as shown in Figure 40. However, for best performance the clock inputs must be driven differentially, thereby reducing susceptibility to common-mode noise. For high input frequency sampling, TI recommends using a clock source with very low jitter. Band-pass filtering of the clock source can help reduce the effects of jitter. There is no change in performance with a non- $50 \%$ duty cycle clock input.


Figure 40. Single-Ended Clock Driving Circuit

### 8.3.2.1 SNR and Clock Jitter

The signal-to-noise ratio of the ADC is limited by three different factors, as shown in Equation 1. Quantization noise (typically 74 dB for a 12-bit ADC) and thermal noise limit SNR at low input frequencies, and the clock jitter sets SNR for higher input frequencies.
$\mathrm{SNR}_{\mathrm{ADC}}[\mathrm{dBC}]=-20 \cdot \log \sqrt{\left(10^{-\frac{\mathrm{SNR}_{\text {Quantization_Noise }}}{20}}\right)^{2}+\left(10-\frac{\mathrm{SNR}_{\text {Thermal_ Noise }}}{20}\right)^{2}+\left(10^{\left.-\frac{\mathrm{SNR}_{\text {Jitier }}}{20}\right)^{2}}\right.}$
The SNR limitation resulting from sample clock jitter can be calculated with Equation 2.
$\mathrm{SNR}_{\text {Jitter }}[\mathrm{dBc}]=-20 \cdot \log \left(2 \pi \cdot \mathrm{f}_{\text {in }} \cdot \mathrm{t}_{\text {Jitter }}\right)$

The total clock jitter ( $\mathrm{T}_{\text {jiter }}$ ) has two components: the internal aperture jitter ( 130 fs for the device) which is set by the noise of the clock input buffer and the external clock. $\mathrm{T}_{\text {jitter }}$ can be calculated with Equation 3.
$t_{\text {jitter }}=\sqrt{\left(t_{\text {Jititer_Ex._Clock_Input }}\right)^{2}+\left(t_{\text {Aperture_ADC }}\right)^{2}}$
External clock jitter can be minimized by using high-quality clock sources and jitter cleaners as well as band-pass filters at the clock input; a faster clock slew rate improves the ADC aperture jitter. The devices have a typical thermal noise of 70.6 dBFS and internal aperture jitter of 130 fs . The SNR, depending on the amount of external jitter for different input frequencies, is shown in Figure 41.


Figure 41. SNR vs Frequency for Different Clock Jitter

### 8.3.3 Digital Output Interface

The devices offer two different output format options, thus making interfacing to a field-programmable gate array (FPGA) or an application-specific integrated circuit (ASIC) easy. Each option can be easily programmed using the serial interface, as shown in Table 1. The output interface options are:

- One-wire, 1 x frame clock, 12 x serialization with the DDR bit clock and
- Two-wire, $1 x$ frame clock, $6 x$ serialization with the DDR bit clock.

Table 1. Interface Rates

| INTERFACE OPTIONS | SERIALIZATION | RECOMMENDED SAMPLING FREQUENCY (MSPS) |  | BIT CLOCK FREQUENCY (MHz) | FRAME CLOCK FREQUENCY (MHz) | SERIAL DATA RATE PER WIRE (Mbps) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MINIMUM | MAXIMUM |  |  |  |
| One-wire | 12x | 15 |  | 90 | 15 | 180 |
|  |  |  | 25 | 150 | 25 | 300 |
| Two-wire (Default after Reset) | 6x | $20^{(1)}$ |  | 60 | 20 | 120 |
|  |  |  | 25 | 75 | 25 | 150 |

(1) Use the LOW SPEED ENABLE register bits for low speed operation; see .

### 8.3.3.1 One-Wire Interface: 12x Serialization

In this interface option, the device outputs the data of each ADC serially on a single LVDS pair (one-wire). The data are available at the rising and falling edges of the bit clock (DDR bit clock). The ADC outputs a new word at the rising edge of every frame clock, starting with the LSB. The data rate is $12 x$ sample frequency ( 12 x serialization).

### 8.3.3.2 Two-Wire Interface: 6x Serialization

In two-wire interface, the output data rate is $6 x$ sample frequency because six data bits are output every clock cycle on each differential pair. Each ADC sample is sent over the two wires with the six MSBs on Dx1P, Dx1M and the six LSBs on Dx0P, Dx0M, as shown in Figure 42.


Figure 42. Output Timing Diagram

### 8.4 Device Functional Modes

### 8.4.1 Input Clock Divider

The devices are equipped with an optional internal divider on the clock input. The clock divider allows operation with a faster input clock (divide by 2 and divide by 4 options programmable using SPI), thus simplifying the system clock distribution design.

### 8.4.2 Chopper Functionality

The devices are equipped with an internal chopper front-end. Enabling the chopper function swaps the ADC noise spectrum by shifting the $1 / f$ noise from dc to $f_{S} / 2$. Figure 43 shows the noise spectrum with the chopper off and Figure 44 shows the noise spectrum with the chopper on. This function is especially useful in applications requiring good ac performance at low input frequencies or in dc-coupled applications. The chopper can be enabled via SPI register writes and is recommended for input frequencies below 30 MHz . The chopper function creates a spur at $\mathrm{f}_{\mathrm{S}} / 2$ that must be filtered out digitally.


Figure 43. Chopper Off


Figure 44. Chopper On

### 8.4.3 Power-Down Control

The power-down functions of the ADC3421-Q1 can be controlled either through the parallel control pin (PDN) or through an SPI register setting (see register 15h). The PDN pin can also be configured via SPI to a global powerdown or standby functionality, as shown in Table 2.

Table 2. Power-Down Modes

| FUNCTION | POWER CONSUMPTION (mW) | WAKE-UP TIME ( $\mu \mathbf{s}$ ) |
| :---: | :---: | :---: |
| Global power-down | 5 | 85 |
| Standby | 34 | 35 |

### 8.4.4 Internal Dither Algorithm

The ADC3421-Q1 uses an internal dither algorithm to achieve high SFDR and a clean spectrum. However, the dither algorithm marginally degrades SNR, creating a trade-off between SNR and SFDR. If desired, the dither algorithm can be turned off by using the DIS DITH CHx registers bits. Figure 45 and Figure 46 show the effect of using dither algorithms.


### 8.4.5 Summary of Performance Mode Registers

Table 3 lists the location, value, and functions of performance mode registers in the device.
Table 3. Performance Modes

| MODE | REGISTER SETTINGS | DESCRIPTION |
| :--- | :--- | :--- |
| Special modes | Registers 139 (bit 3), 239 (bit 3), 439 (bit 3), and 539 (bit 3) | Always write 1 for best performance |
| Disable dither | Registers 1 (bits 7:0), 134 (bits 5 and 3), 234 (bits 5 and 3), <br> 434 (bits 5 and 3), and 534 (bits 5 and 3) | Disable dither to improve SNR |
| Disable chopper | Registers 122 (bit 1), 222 (bit 1), 422 (bit 1), and 522 (bit 1) | Disable chopper (shifts 1/f noise floor at dc) |
| High IF modes | Registers 11Dh (bit 1), 21Dh (bit 1), 31Dh (bit 7 and bit 1), 41Dh <br> (bit 1), 51Dh (bit 1), 308h (bits 7-6), 608h (bits 7-6) and 61Dh <br> (bit 7 and bit 1) | Improves HD3 by a couple of dB for IF > 100 MHz |

### 8.4.6 Device Diagnostic Modes

The device offers various diagnostic modes to check proper device operation at system level. These modes can be enabled using the SPI. Outputs of these modes are stored in diagnostic read-only registers.

### 8.4.6.1 Internal Reference and Clock Status Check

Device is equipped with a mode to verify presence of a valid input clock, as well as status of on-chip ADC reference. When a valid clock input clock is absent at input clock pins (CLKP,CLKM) of ADC, device sets register bit CLK STATUS to ' 1 '. Similarly, if internal reference block is malfunctioning for a channel, device sets register bits REF STATUS CHx to ' 1 '. To read the status of internal reference from these pins:

1. First enable reference status check by setting register bit EN REF STATUS CHECK to ' 1 '.
2. Read back register bits REF STATUS CHx on SDATA pin for desired channel ( $x=A, B, C$ or $D$ ).

### 8.4.6.2 DC Input check

In this mode, an internally generated DC voltage can be forced by device to its analog inputs. Before forcing internal DC voltage, analog inputs must float. To enable forcing internal DC voltage, register bit EN DC FORCE must be set HIGH. Forced voltage is programmable by register bits DC FORCE[2:0], applied to all four channels together. In terms of output code, typical value of programmed DC voltage is given by equation mentioned below:
Output code $=368 \times$ DC FORCE[2:0] +745 .
Output code is available on LVDS data outputs.

### 8.4.6.3 Mean and Variance Measurement

Mean and variance values of the ADC output can be analyzed using the on-chip statistical module available for individual channel for a programmable length of samples. These values are stored in register bits MEAN[11:0] and VAR[11:0] in 2s complement format. Equation for computing mean and variance values respectively are given below:

- Mean $=\bar{x}=\sum_{n=1}^{N} \frac{S(n)}{N}$
- Variance $=\sum_{n=1}^{N} \frac{|S(n)-\bar{x}|}{N}$

Where $\mathrm{S}(\mathrm{n})$ is $\mathrm{n}^{\text {th }}$ sample, N is total number of samples used for computation, programmed by register bits SAMPLES FOR STATS[1:0].
Follow steps mentioned below to read the mean and variance:

1. Enable Statistical Module by setting bit EN STATS to ' 1 '.
2. Select desired channel through bits STATS CH SEL[1:0].
3. Program number of samples, N , using register bits SAMPLES FOR STATS[1:0].
4. Wait for at least 4 N samples for module to compute and update the results.
5. Disable Statistical Module by resetting EN STATS bit to ' 0 '.
6. Read back mean and variance values from register bits MEAN[11:0] and VAR[11:0]. These values are in 2 s complement format.

### 8.4.6.4 Temperature Sensor

The device is equipped with a temperature sensor to measure internal junction temperature.
The temperature sensor output is a 9-bit digital data available in 2 s complement format directly representing temperature in degree Celsius units. Temperature data is internally updated every $1024 \times \mathrm{T}_{\text {CLK }} \times 16$ seconds where $\mathrm{T}_{\text {CLK }}$ period of sampling clock in seconds. Follow the steps mentioned below to read temperature sensor's output:

1. Enable temperature sensor by setting bits EN TEMP SENSE and EN TEMP SENSE CONV to ' 1 '.
2. Wait for at least $1024 \times \mathrm{T}_{\text {CLK }} \times 16$ seconds for temperature sensor to update the data.
3. Disable temperature sensor by resetting the bit EN TEMP SENSE to ' 0 '.
4. Load temperature sensor's data to register bits TEMPDATA[8:0] by setting register bit EN TEMP DATA READOUT to ' 1 '.
5. Readout 9-bit temperature data from register bits TEMPDATA[8:0] located in register addresses 10 h and 11 h .

ADC3421-Q1
SBAS958A -DECEMBER 2019-REVISED JUNE 2020
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### 8.5 Programming

The ADC3421-Q1 can be configured using a serial programming interface, as described in this section.

### 8.5.1 Serial Interface

The device has a set of internal registers that can be accessed by the serial interface formed by the SEN (serial interface enable), SCLK (serial interface clock), SDATA (serial interface data), and SDOUT (serial interface data output) pins. Serially shifting bits into the device is enabled when SEN is low. Serial data SDATA are latched at every SCLK rising edge when SEN is active (low). The serial data are loaded into the register at every 24th SCLK rising edge when SEN is low. When the word length exceeds a multiple of 24 bits, the excess bits are ignored. Data can be loaded in multiples of 24 -bit words within a single active SEN pulse. The interface can function with SCLK frequencies from 20 MHz down to very low speeds (of a few hertz) and also with a non-50\% SCLK duty cycle.

## Programming (continued)

### 8.5.1.1 Register Initialization

After power-up, the internal registers must be initialized to their default values through a hardware reset by applying a high pulse on the RESET pin (of durations greater than 10 ns ), as shown in Figure 47. If required, the serial interface registers can be cleared during operation either:

1. Through a hardware reset, or
2. By applying a software reset. When using the serial interface, set the RESET bit (DO in register address 06h) high. This setting initializes the internal registers to the default values and then self-resets the RESET bit low. In this case, the RESET pin is kept low.

### 8.5.1.1.1 Serial Register Write

The device internal register can be programmed with these steps:

1. Drive the SEN pin low,
2. Set the R/W bit to 0 (bit A15 of the 16 -bit address),
3. Set bit A14 in the address field to 1 ,
4. Initiate a serial interface cycle by specifying the address of the register (A13 to A0) whose content must be written, and
5. Write the 8 -bit data that are latched in on the SCLK rising edge.

Figure 47 and Table 4 show the timing requirements for the serial register write operation.


RESET


Figure 47. Serial Register Write Timing Diagram

Table 4. Serial Interface Timing ${ }^{(1)}$

|  |  | MIN | TYP |
| :--- | ---: | ---: | :---: |
| $\mathrm{f}_{\text {SCLK }}$ | SCLK frequency (equal to $\left.1 / \mathrm{t}_{\text {SCLK }}\right)$ | $>\mathrm{dc}$ | MAX |
| $\mathrm{t}_{\text {SLOADS }}$ | SEN to SCLK setup time | 20 | UNIT |
| $\mathrm{t}_{\text {SLOADH }}$ | SCLK to SEN hold time | 25 | ns |
| $\mathrm{t}_{\text {DSU }}$ | SDIO setup time | 25 | ns |
| $\mathrm{t}_{\text {DH }}$ | SDIO hold time | 25 | ns |

(1) Typical values are at $25^{\circ} \mathrm{C}$, full temperature range is from $\mathrm{T}_{\mathrm{MIN}}=-40^{\circ} \mathrm{C}$ to $\mathrm{T}_{\mathrm{MAX}}=85^{\circ} \mathrm{C}$, and $\mathrm{AVDD}=\mathrm{DVDD}=1.8 \mathrm{~V}$, unless otherwise noted.

### 8.5.1.1.2 Serial Register Readout

The device includes a mode where the contents of the internal registers can be read back using the SDOUT pin. This readback mode may be useful as a diagnostic check to verify the serial interface communication between the external controller and the ADC. The procedure to read the contents of the serial registers is as follows:

1. Drive the SEN pin low.
2. Set the R/W bit (A15) to 1 . This setting disables any further writes to the registers.
3. Set bit A14 in the address field to 1 .
4. Initiate a serial interface cycle specifying the address of the register (A13 to A0) whose content must be read.
5. The device outputs the contents ( D 7 to DO ) of the selected register on the SDOUT pin.
6. The external controller can latch the contents at the SCLK rising edge.
7. To enable register writes, reset the R/W register bit to 0 .

When READOUT is disabled, the SDOUT pin is in a high-impedance mode. If serial readout is not used, the SDOUT pin must float. Figure 48 shows a timing diagram of the serial register read operation. Data appear on the SDOUT pin at the SCLK falling edge with an approximate delay ( $\mathrm{t}_{\text {SD_DELAY }}$ ) of 20 ns , as shown in Figure 49.


Figure 48. Serial Register Read Timing Diagram


Figure 49. SDOUT Timing Diagram

### 8.5.2 Register Initialization

After power-up, the internal registers must be initialized to their default values through a hardware reset by applying a high pulse on the RESET pin, as shown in Figure 50 and Table 5.


Figure 50. Initialization of Serial Registers after Power-Up

Table 5. Power-Up Timing

|  |  | MIN | TYP |
| :--- | :--- | ---: | ---: |
| $t_{1}$ | Power-on delay from power-up to active high RESET pulse | 1 | MAX |
| $\mathrm{t}_{2}$ | Reset pulse duration: active high RESET pulse duration | 10 | ms |
| $\mathrm{t}_{3}$ | Register write delay from RESET disable to SEN active | 100 | ns |

If required, the serial interface registers can be cleared during operation either:

1. Through hardware reset, or
2. By applying a software reset. When using the serial interface, set the RESET bit (D0 in register address 06h) high. This setting initializes the internal registers to the default values and then self-resets the RESET bit low. In this case, the RESET pin is kept low.

### 8.6 Register Maps

Table 6. Register Map Summary

| REGISTER ADDRESS, A[13:0] (Hex) | REGISTER DATA |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Register 01h | DIS DITH CHA |  | DIS DITH CHB |  | DIS DITH CHC |  | DIS DITH CHD |  |
| Register 02h | STATS CH SEL[1:0] |  | 0 | 0 | 0 | 0 | 0 | 0 |
| Register 03h | 0 | 0 | 0 | 0 | 0 | 0 | 0 | ODD EVEN |
| Register 04h | 0 | 0 | 0 | 0 | 0 | 0 | 0 | FLIP WIRE |
| Register 05h | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1W-2W |
| Register 06h | 0 | 0 | 0 | 0 | 0 | 0 | $\begin{gathered} \text { TEST } \\ \text { PATTERN EN } \end{gathered}$ | RESET |
| Register 07h | 0 | 0 | 0 | 0 | 0 | 0 | 0 | OVR ON LSB |
| Register 09h | 0 | 0 | 0 | 0 | 0 | 0 | ALIGN TEST PATTERN | DATA FORMAT |
| Register 0Ah | CHA TEST PATTERN |  |  |  | CHB TEST PATTERN |  |  |  |
| Register 0Bh | CHC TEST PATTERN 0 |  |  |  | CHD TEST PATTERN |  |  |  |
| Register 0Eh | CUSTOM PATTERN[11:4] |  |  |  |  |  |  |  |
| Register 0Fh | CUSTOM PATTERN[3:0] |  |  |  | 0 | 0 | 0 | 0 |
| Register 10h | $\begin{gathered} \text { REF STATUS } \\ \text { CHB OR } \\ \text { TEMPDATA [2] } \end{gathered}$ | $\begin{gathered} \text { REF STATUS } \\ \text { CHD OR } \\ \text { TEMPDATA [1] } \end{gathered}$ | $\begin{aligned} & \text { REF STATUS } \\ & \text { CHA OR } \\ & \text { TEMPDATA [0] } \end{aligned}$ | CLK STATUS | TEMPDATA[6:4] |  |  | $\begin{gathered} \text { REF STATUS } \\ \text { CHC OR } \\ \text { TEMPDATA [3] } \end{gathered}$ |
| Register 11h | 0 | 0 | TEMPDATA [8:7] |  | 0 | 0 | 0 | 0 |
| Register 13h | 0 | EN REF STATUS CHECK | EN DC FORCE | EN STATS | 0 | 0 | LOW SPEED ENABLE |  |
| Register 14h | 0 | EN TEMP SENS CONV | EN TEMP SENSE | 0 | 0 | EN TEMP DATA READOUT | 0 | 0 |
| Register 15h | CHA PDN | CHB PDN | CHC PDN | CHD PDN | STANDBY | GLOBAL PDN | 0 | CONFIG PDN PIN |
| Register 16h | MEAN[5:0] |  |  |  |  |  | 0 | 0 |
| Register 17h | 0 | 0 | MEAN[11:6] |  |  |  |  |  |
| Register 18h | VAR[5:0] |  |  |  |  |  | 0 | 0 |
| Register 19h | 0 | 0 | VAR[11:6] |  |  |  |  |  |
| Register 25h | LVDS SWING |  |  |  |  |  |  |  |
| Register 27h | CLK DIV |  | 0 | 0 | 0 | 0 | 0 | 0 |
| Register 4Bh | 0 | 0 | 0 | 0 | 0 | 0 | SAMPLES FOR STATS[1:0] |  |
| Register 11Dh | 0 | 0 | 0 | 0 | 0 | 0 | HIGH IF MODEO | 0 |
| Register 122h | 0 | 0 | 0 | 0 | 0 | 0 | $\begin{gathered} \text { DIS CHOP } \\ \text { CHA } \end{gathered}$ | 0 |
| Register 134h | 0 | 0 | DIS DITH CHA | 0 | DIS DITH CHA | 0 | 0 | 0 |
| Register 139h | 0 | 0 | 0 | 0 | SP1 CHA | 0 | 0 | 0 |
| Register 21Dh | 0 | 0 | 0 | 0 | 0 | 0 | HIGH IF MODE1 | 0 |
| Register 222h | 0 | 0 | 0 | 0 | 0 | 0 | $\begin{aligned} & \text { DIS CHOP } \\ & \text { CHD } \end{aligned}$ | 0 |
| Register 234h | 0 | 0 | DIS DITH CHD | 0 | DIS DITH CHD | 0 | 0 | 0 |
| Register 239h | 0 | 0 | 0 | 0 | SP1 CHD | 0 | 0 | 0 |
| Register 308h | HIGH IF MODE <5:4> |  | 0 | 0 | 0 | 0 | 0 | 0 |
| Register 31Dh | HIGH IF MODE4 | 0 | 0 | 0 | 0 | 0 | HIGH IF MODE4 | 0 |
| Register 41Dh | 0 | 0 | 0 | 0 | 0 | 0 | HIGH IF MODE2 | 0 |
| Register 422h | 0 | 0 | 0 | 0 | 0 | 0 | $\begin{gathered} \text { DIS CHOP } \\ \text { CHB } \end{gathered}$ | 0 |
| Register 434h | 0 | 0 | DIS DITH CHB | 0 | DIS DITH CHB | 0 | 0 | 0 |

## Register Maps (continued)

Table 6. Register Map Summary (continued)

|  |  |  |  |  | R DATA |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A[13:0] (Hex) | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Register 439h | 0 | 0 | 0 | 0 | SP1 CHB | 0 | 0 | 0 |
| Register 51Dh | 0 | 0 | 0 | 0 | 0 | 0 | HIGH IF MODE3 | 0 |
| Register 522h | 0 | 0 | 0 | 0 | 0 | 0 | $\begin{aligned} & \text { DIS CHOP } \\ & \text { CHC } \end{aligned}$ | 0 |
| Register 534h | 0 | 0 | DIS DITH CHC | 0 | DIS DITH CHC | 0 | 0 | 0 |
| Register 539h | 0 | 0 | 0 | 0 | SP1 CHC | 0 | 0 | 0 |
| Register 608h | HIGH IF MODE <7:6> |  | 0 | 0 | 0 | 0 | 0 | 0 |
| Register 61Dh | HIGH IF MODE5 | 0 | 0 | 0 | 0 | 0 | HIGH IF MODE5 | 0 |
| Register 70Ah | 0 | 0 | 0 | 0 | 0 | 0 | 0 | PDN SYSREF |
| Register 71Ah | 0 | 0 | 0 | 0 | DC FORCE[2:0] |  |  | 0 |

### 8.6.1 Serial Register Description

### 8.6.1.1 Register 01h (address $=01 \mathrm{~h}$ )

Figure 51. Register 01h


LEGEND: R/W = Read/Write; $-\mathrm{n}=$ value after reset
Table 7. Register 01h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-6$ | DIS DITH CHA | R/W | Oh | These bits enable or disable the on-chip dither. Control this bit <br> along with bits 5 and 3 of register 134h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel A. In this mode, SNR typically <br> improves by 0.2 dB at 70 MHz. |
| $5-4$ | DIS DITH CHB | R/W | Oh | These bits enable or disable the on-chip dither. Control this bit <br> along with bits 5 and 3 of register 434h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel B. In this mode, SNR typically <br> improves by 0.2 dB at 70 MHz. |
| $3-2$ | DIS DITH CHC | R/W | Oh | These bits enable or disable the on-chip dither. Control this bit <br> along with bits 5 and 3 of register 534 h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel B. In this mode, SNR typically <br> improves by 0.2 dB at 70 MHz. |
| $1-0$ | DIS DITH CHD | R/W | Oh | These bits enable or disable the on-chip dither. Control this bit <br> along with bits 5 and 3 of register 234h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel B. In this mode, SNR typically <br> improves by 0.2 dB at 70 MHz. |

### 8.6.1.2 Register 02h (address = 02h)

Figure 52. Register 02h

| 7 | 6 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| STATS CH SEL[1:0] | 0 | 0 | 0 | 0 | 0 | 0 |
| R/W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 8. Register 02h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-6$ | STATS CH SEL[1:0] | R/W | Oh | These bits select desired channel for statistical data computation <br> $00=$ Channel A, <br> $01=$ Channel B, <br> $10=$ Channel C, <br> $11=$ Channel D |
| $5-0$ | 0 | W | Oh | Must write 0. |

8.6.1.3 Register 03h (address = 03h)

Figure 53. Register 03h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| $W-0 h$ | $W-O h$ | $W-O h$ | $W-O h$ | Oh Oh | W-Oh |  |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 9. Register 03h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-6$ | 0 | W | Oh | Must write 0. |
| 0 | ODD EVEN | R/W | Oh | This bit selects the bit sequence on the output wires (in 2-wire <br> mode only). <br> $0=$ Bits $0,1,2$, and so forth appear on wire-0; bits $7,8,9$, and <br> so forth appear on wire-1. <br> $1=$ Bits 0, 2, 4, and so forth appear on wire-0; bits 1, 3, 5, and <br> so forth appear on wire-1. |

### 8.6.1.4 Register 04h (address = 04h)

Figure 54. Register 04h

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | FLIP WIRE |
| W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 10. Register 04h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0. |
| 0 | FLIP WIRE | R/W | Oh | This bit flips the data on the output wires. Valid only in two wire <br> configuration. <br> $0=$ Default <br> $1=$ Data on output wires is flipped. Pin D0x becomes D1x, and <br> vice versa. |

### 8.6.1.5 Register 05h (address = 05h)

Figure 55. Register 05h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1W-2W |
| W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | W-0h | W-0h | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 11. Register 05h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0. |
| 0 | 1 W-2W | R/W | Oh | This bit transmits output data on either one or two wires. <br> $0=$ Output data are transmitted on two wires (Dx0P, Dx0M and <br> Dx1P, Dx1M) <br> $1=$ Output data are transmitted on one wire (Dx0P, Dx0M). |

### 8.6.1.6 Register 06h (address = 06h)

Figure 56. Register 06h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | TEST PATTERN EN | RESET |
| W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | R/W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 12. Register 06h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| 1 | TEST PATTERN EN | R/W | Oh | This bit enables test pattern selection for the digital outputs. <br> $0=$ Normal output <br> $1=$ Test pattern output enabled |
| 0 | RESET | R/W | Oh | This bit applies a software reset. <br> This bit resets all internal registers to the default values and self- <br> clears to 0. |

### 8.6.1.7 Register 07h (address = 07h)

Figure 57. Register 07h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| $W-0 h$ | $W-O h$ | $W-O h$ | $W-O h$ | OhR ON LSB |  |  |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 13. Register 07h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0. |
| 0 | OVR ON LSB | R/W | Oh | This bit provides OVR information on the LSB bits. <br> $0=$ Output data bit 0 functions as the LSB of the 12-bit data <br> $=$ Output data bit 0 carries the overrange (OVR) information |

### 8.6.1.8 Register 09h (address = 09h)

Figure 58. Register 09h

| 7 | 6 | 5 | 4 | 2 | 0 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | ALIGN TEST PATTERN | DATA FORMAT |
| $W-0 h$ | $W-O h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $R / W-0 h$ | $R / W-0 h$ |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 14. Register 09h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| 1 | ALIGN TEST PATTERN | R/W | Oh | This bit aligns the test patterns across the outputs of both <br> channels. <br> $0=$ Test patterns of both channels are free running <br> $1=$ Test patterns of both channels are aligned |
| 0 | DATA FORMAT | R/W | Oh | This bit selects th digital output data format. <br> $0=$ Twos complement <br> $1=$ Offset binary |

8.6.1.9 Register OAh (address = OAh)

Figure 59. Register 0Ah

| 7 | 6 | 5 | 3 | 2 |
| :---: | :---: | :---: | :---: | :---: |
| CHA TEST PATTERN |  | 1 |  |  |
| R/W-Oh | CHB TEST PATTERN |  |  |  |

LEGEND: R/W = Read/Write; -n = value after reset
Table 15. Register OAh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7-4 | CHA TEST PATTERN | R/W | Oh | These bits control the test pattern for channel A after the TEST PATTERN EN bit is set. <br> $0000=$ Normal operation <br> $0001=$ All 0's <br> $0010=$ All 1's <br> 0011 = Toggle pattern: data alternate between 101010101010 and 010101010101 <br> 0100 = Digital ramp: data increment by 1 LSB every clock cycle from code 0 to 4095 <br> $0101=$ Custom pattern: output data are the same as programmed by the CUSTOM PATTERN register bits <br> 0110 = Deskew pattern: data are AAAh <br> $1000=$ PRBS pattern: data are a sequence of pseudo random numbers <br> $1001=8$-point sine-wave: data are a repetitive sequence of the following eight numbers that form a sine-wave: $0,599,2048$, 3496, 4095, 3496, 2048, and 599 <br> Others = Do not use |
| 3-0 | CHB TEST PATTERN | R/W | Oh | These bits control the test pattern for channel B after the TEST PATTERN EN bit is set. <br> $0000=$ Normal operation <br> $0001=$ All 0's <br> $0010=$ All 1's <br> 0011 = Toggle pattern: data alternate between 101010101010 and 010101010101 <br> 0100 = Digital ramp: data increment by 1 LSB every clock cycle from code 0 to 4095 <br> $0101=$ Custom pattern: output data are the same as programmed by the CUSTOM PATTERN register bits <br> 0110 = Deskew pattern: data are AAAh <br> $1000=$ PRBS pattern: data are a sequence of pseudo random numbers <br> $1001=8$-point sine-wave: data are a repetitive sequence of the following eight numbers that form a sine-wave: $0,599,2048$, 3496, 4095, 3496, 2048, and 599 <br> Others = Do not use |

### 8.6.1.10 Register OBh (address = OBh)

Figure 60. Register 0Bh

| 7 | 6 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CHC TEST PATTERN |  | CHD TEST PATTERN |  |  |  |
| R/W-Oh | R/W-Oh |  |  |  |  |

LEGEND: R/W = Read/Write; -n = value after reset
Table 16. Register OBh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7-4 | CHC TEST PATTERN | R/W | Oh | These bits control the test pattern for channel C after the TEST PATTERN EN bit is set. <br> $0000=$ Normal operation <br> $0001=$ All 0's <br> $0010=$ All 1's <br> 0011 = Toggle pattern: data alternate between 101010101010 and 010101010101. <br> 0100 = Digital ramp: data increment by 1 LSB every clock cycle from code 0 to 4095. <br> 0110 = Custom pattern: output data are the same as programmed by the CUSTOM PATTERN register bits. <br> 1000 = Deskew pattern: data are AAAh. <br> $1010=$ PRBS pattern: data are a sequence of pseudo random numbers. <br> $1011=8$-point sine wave: data are a repetitive sequence of the following eight numbers that form a sine-wave: $0,599,2048$, $3496,4095,3496,2048,599 .$ <br> Others = Do not use |
| 3-0 | CHD TEST PATTERN | R/W | Oh | These bits control the test pattern for channel $D$ after the TEST PATTERN EN bit is set. <br> $0000=$ Normal operation <br> $0001=$ All 0's <br> $0010=$ All 1's <br> 0011 = Toggle pattern: data alternate between 101010101010 and 010101010101. <br> 0100 = Digital ramp: data increment by 1 LSB every clock cycle from code 0 to 4095. <br> 0110 = Custom pattern: output data are the same as programmed by the CUSTOM PATTERN register bits. <br> 1000 = Deskew pattern: data are AAAh. <br> $1010=$ PRBS pattern: data are a sequence of pseudo random numbers. <br> $1011=8$-point sine wave: data are a repetitive sequence of the following eight numbers that form a sine-wave: 0, 599, 2048, $3496,4095,3496,2048,599 .$ <br> Others = Do not use |

### 8.6.1.11 Register OEh (address = OEh)

Figure 61. Register 0Eh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |

LEGEND: R/W = Read/Write; $-\mathrm{n}=$ value after reset
Table 17. Register OEh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | CUSTOM PATTERN[11:4] | R/W | Oh | These bits set the 12-bit custom pattern (bits 11-4) for all <br> channels. |

### 8.6.1.12 Register OFh (address = OFh)

Figure 62. Register 0Fh

| 7 | 6 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CUSTOM PATTERN[3:0] | 0 | 0 | 0 | 0 |  |  |
| R/W-Oh | W-Oh | W-Oh | W-Oh | W-0h |  |  |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; -n = value after reset
Table 18. Register OFh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-4$ | CUSTOM PATTERN[3:0] | R/W | Oh | These bits set the 12-bit custom pattern (bits 3-0) for all <br> channels. |
| $3-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.13 Register 10 h (address $=10 \mathrm{~h}$ )

Figure 63. Register 10h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{gathered} \text { REF STATUS } \\ \text { CHB OR } \\ \text { TEMPDATA [2] } \end{gathered}$ | $\begin{gathered} \text { REF STATUS } \\ \text { CHD OR } \\ \text { TEMPDATA [1] } \end{gathered}$ | $\begin{gathered} \text { REF STATUS } \\ \text { CHA OR } \\ \text { TEMPDATA [0] } \end{gathered}$ | CLK STATUS |  | TEMPDATA [6:4] |  | $\begin{aligned} & \text { REF STATUS } \\ & \text { CHC OR } \\ & \text { TEMPDATA [3] } \end{aligned}$ |
| Read Only | Read Only | Read Only | Read Only |  | Read Only |  | Read Only |

LEGEND: R/W = Read/Write; $W=$ Write only; $-n=$ value after reset
Table 19. Register 10h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-5,0$ | REF STATUS CHB, REF STATUS <br> CHD, REF STATUS CHA, REF <br> STATUS CHC | Read <br> Only | Oh | When internal reference diagnostic is enabled by setting EN <br> REF STATUS CHECK bit to '1', these bits carry status of <br> internal reference for corresponding channel. <br> See Internal Reference and Clock Status Check for details. <br> Note that these bits are multiplexed with temperature sensor's <br> data and carry TEMPDATA[3:0] if temperature sensor's is <br> enabled. |
| 4 | CLK STATUS |  | Read <br> Only | Oh |
| $7-5,3-1,0$ | TEMPDATA [6:0] | Read <br> Only | Oh | This bit indicates presence of input clock. By default, device sets <br> this bit 0. If input clock is absent, this bit becomes '1' |
| When temperature sensor's data is being read, these bits carry |  |  |  |  |
| seven MSBs of temperature sensor's 9-bit data. Remaining two |  |  |  |  |
| LSBs are available on address 11h bit 5:4. |  |  |  |  |
| See Temperature Sensor for details of operation. |  |  |  |  |

### 8.6.1.14 Register 11h (address = 11h)

Figure 64. Register 11h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | TEMPDATA [8:7] | 0 | 0 | 0 |  |
| W-Oh | W-Oh | Read Only | W-Oh | W-0h | W-0h |  |

LEGEND: R/W = Read/Write; $W=$ Write only; $-n=$ value after reset
Table 20. Register 11h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-6$ | 0 | W | Oh | Must write 0. |
| $5-4$ | TEMPDATA [8:7] | Read <br> Only | Oh | These bits represent digital equivalent of temperature in 2s <br> complement format. |
| $3-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.15 Register 13h (address = 13h)

Figure 65. Register 13h

| 7 | 6 | 5 | 4 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | EN REF <br> STATUS <br> CHECK | EN DC FORCE | EN STATS | 0 | 0 | LOW SPEED ENABLE |
| W-Oh | R/W-Oh | R/W-Oh | R/W-0h | W-Oh | W-0h | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 21. Register 13h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | 0 | W | Oh | Must write 0. |
| 6 | EN REF STATUS CHECK | R/W | Oh | This Bit Enables reference diagnostic check. Must be set to '1' <br> before reading reference status from REF STATUS CHECK CHx <br> bits. |
| 5 | EN DC FORCE | R/W | Oh | This Bit Enables internal DC voltage force diagnostic check <br> together for all channels. Must be set to '1' before forcing <br> internal DC voltage through DC FORCE[2:0] bits. |
| 4 | EN STATS | R/W | Oh | This bit enables inter Statistics Module for mean and variance <br> computation. After this bit is set to '1', statistical module for <br> desired channel can be selected by using bits STATS CH <br> SEL[1:0] |
| $3-2$ | 0 | W | Oh | Must write 0. |
| $1-0$ | LOW SPEED ENABLE | R/W | Oh | Enables low speed operation in 1-wire and 2-wire mode. <br> Depending upon sampling frequency, write this bit as per <br> Table 22 |

Table 22. LOW SPEED ENABLE Register Settings across $f_{s}$

| $\mathbf{f}_{\mathbf{S}}$, MSPS |  | REGISTER BIT LOW SPEED ENABLE |  |
| :---: | :---: | :---: | :---: |
| MIN | MAX | 1- Wire Mode | 2-Wire Mode |
| 20 | 25 | 10 | 11 |
| 15 | 20 | 10 | Not supported |

8.6.1.16 Register 14h (address $=14 h$ )

Figure 66. Register 14h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | EN TEMP <br> SENS CONV | EN TEMP <br> SENSE | 0 | 0 | EN TEMP <br> DATA <br> READOUT | 0 | 0 |
| W-Oh |  |  |  |  |  |  |  |

LEGEND: R/W = Read/Write; $W=$ Write only; $-n=$ value after reset
Table 23. Register 14h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | 0 | W | Oh | Must write 0. |
| 6 | EN TEMP SENS CONV | R/W | Oh | This bit enables the temperature-to-digital conversion process of <br> temperature sensor. This bit can be set to '11 after temperature <br> sensor is enabled by setting EN TEMP SENSE bit to '1'. |
| 5 | EN TEMP SENSE | R/W | Oh | This bit enables temperature sensor present inside device |
| $4-3$ | 0 | W | Oh | Must write 0. |
| 2 | EN TEMP DATA READOUT | R/W | Oh | This bit places the 9 -bit digital equivalent of temperature on <br> register bits TEMPDATA[8:0]. |
| $1-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.17 Register 15h (address = 15h)

Figure 67. Register 15h

| 7 | 6 | 5 | 4 | 3 | 2 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CHA PDN | CHB PDN | CHC PDN | CHD PDN | STANDBY | GLOBAL PDN | 0 | CONFIG PDN |
| PIN |  |  |  |  |  |  |  |
| W-Oh | R/W-Oh | R/W-Oh | W-Oh | R/W-Oh | R/W-Oh | W-Oh |  |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 24. Register 15h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | CHA PDN | W | Oh | $0=$ Normal operation <br> $1=$ Power-down channel A |
| 6 | CHB PDN | R/W | Oh | $0=$ Normal operation <br> $1=$ Power-down channel B |
| 5 | CHC PDN | R/W | Oh | $0=$ Normal operation <br> $1=$ Power-down channel C |
| 4 | CHD PDN | W | Oh | $0=$ Normal operation <br> $1=$ Power-down channel D |
| 3 | STANDBY | R/W | Oh | The ADCs of both channels enter standby. <br> $0=$ Normal operation <br> $1=$ Standby |
| 2 | GLOBAL PDN | R/W | Oh | $0=$ Normal operation <br> $1=$ Global power-down |
| 1 | 0 | R/W | Oh | Must write 0. <br> 0 |
| CONFIG PDN PIN | This bit configures the PDN pin as either a global power-down or <br> standby pin. <br> $0=$ Logic high voltage on the PDN pin sends the device into <br> global power-down <br> $1=$ Logic high voltage on the PDN pin sends the device into <br> standby |  |  |  |

### 8.6.1.18 Register 16h (address $=16 h$ )

Figure 68. Register 16h

| 7 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | ---: | ---: | :---: | :---: |
|  | MEAN[5:0] | Read Only |  | 0 | 0 |
|  |  |  | W-0h | W-0h |  |

LEGEND: R/W = Read/Write; $W=$ Write only; $-n=$ value after reset
Table 25. Register 16h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-2$ | MEAN[5:0] | Read <br> Only | Oh | These bits represent mean value in 2s complement format <br> computed over programmed number of samples by statistical <br> module. |
| $1-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.19 Register 17h (address $=17 h$ )

Figure 69. Register 17h

| 7 | 6 | 5 | 4 | 3 | 2 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 |  | MEAN[11:6] |  |  |  |
| W-Oh | W-Oh | Read Only |  |  |  |  |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset

Table 26. Register 17h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-6$ | 0 | W | Oh | Must write 0. |
| $5-0$ | MEAN[11:6] | Read <br> Only | Oh | These bits represent mean value in 2s complement format <br> computed over programmed number of samples by statistical <br> module. |

### 8.6.1.20 Register 18h (address = 18h)

Figure 70. Register 18h

| 7 | 5 | 4 | 3 | 2 | 1 |
| :---: | ---: | ---: | ---: | ---: | :---: |
|  | VAR[5:0] | Read Only |  | 0 | 0 |
|  |  | W-0h | W-Oh |  |  |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 27. Register 18h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-2$ | VAR[5:0] | Read <br> Only | Oh | These bits represent variance value in 2s complement format <br> computed over programmed number of samples by statistical <br> module |
| $1-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.21 Register 19h (address $=19 h$ )

Figure 71. Register 19h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 |  | VAR[11:6] |  |  |  |
| W-Oh | W-Oh | Read Only |  |  |  |  |

LEGEND: R/W = Read/Write; $W=$ Write only; $-n=$ value after reset
Table 28. Register 19h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-6$ | 0 | W | Oh | Must write 0. |
| $5-0$ | VAR[11:6] | Read <br> Only | Oh | These bits represent variance value in 2s complement format <br> computed over programmed number of samples by statistical <br> module |

### 8.6.1.22 Register 25h (address = 25h)

Figure 72. Register 25h

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LVDS SWING |  |  |  |  |  |  |
| R/W-Oh |  |  |  |  |  |  |

LEGEND: R/W = Read/Write; $-\mathrm{n}=$ value after reset
Table 29. Register 25h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-0$ | LVDS SWING | R/W | Oh | These bits control the swing of the LVDS outputs (including the <br> data output, bit clock, and frame clock). |

8.6.1.23 Register 27 h (address $=27 h$ )

Figure 73. Register 27h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CLK DIV | 0 | 0 | 0 | 0 | 0 | 0 |  |
| R/W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | W-Oh |  |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 30. Register 27h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-6$ | CLK DIV | R/W | Oh | These bits select the internal clock divider for the input sampling <br> clock. <br> $00=$ Divide-by-1 <br> $01=$ Divide-by-1 <br> $10=$ Divide-by-2 <br> $11=$ Divide-by-4 |
| $5-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.24 Register 4Bh (address = 4Bh)

Figure 74. Register 4Bh

| 7 | 6 | 5 | 4 | 3 | 2 | 10 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | SAMPLES FOR STATS[1:0] |
| W-0h | W-Oh | W-0h | W-0h | W-0h | W-0h | R/W-Oh |

Table 31. Register 4Bh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| $1-0$ | SAMPLES FOR STATS[1:0] | R/W | Oh | These bits program number of samples to be used by statistical <br> module for computation of mean and variance. <br> $00=256$, <br> $01=1024$, <br> $10=4096$, <br> $11=16384$ |

### 8.6.1.25 Register 11Dh (address = 11Dh)

Figure 75. Register 11Dh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| W-0h | W-Oh | W-Oh | W-Oh | W-0h | W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 32. Register 11Dh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| 1 | HIGH IF MODE0 |  |  | Set all register bits belonging to HIGH IF MODE as logic HIGH <br> to improve HD3 by a couple of dB for IF > 100 MHz. |
| 0 | 0 | W | Oh | Must write 0. |

8.6.1.26 Register 122h (address = 122h)

Figure 76. Register 122h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | DIS CHOP CHA |
| $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $R / W-O h$ |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; -n = value after reset
Table 33. Register 122h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| 1 | DIS CHOP CHA | R/W | Oh | This bit disables the chopper. <br> Set this bit to shift the $1 / f$ noise floor at dc. <br> $0=1 / f$ noise floor is centered at $\mathrm{f}_{\mathrm{S}} / 2$ (default) <br> $1=$ Chopper mechanism is disabled; $1 / \mathrm{f}$ noise floor is centered <br> at dc |
| 0 | 0 | W | Oh | Must write 0. |

### 8.6.1.27 Register 134h (address = 134h)

Figure 77. Register 134h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | DIS DITH CHA | 0 | DIS DITH CHA | 0 | 0 | 0 |
| W-Oh | W-Oh | R/W-Oh | W-Oh | R/W-Oh | W-Oh | W-Oh | W-0h |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 34. Register 134h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-6$ | 0 | W | Oh | Must write 0. |
| 5 | DIS DITH CHA | R/W | Oh | Set this bit along with bits 7 and 6 of register 01h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel A. In this mode, SNR typically <br> improves by 0.2 dB at 70 MHz. |
| 4 | 0 | W | Oh | Must write 0. |
| 3 | DIS DITH CHA | R/W | Oh | Set this bit along with bits 7 and 6 of register 01h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel A. In this mode, SNR typically <br> improves by 0.2 dB at 70 MHz. |
| $2-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.28 Register 139h (address $=139 h$ )

Figure 78. Register 139h

| 7 | 6 | 5 | 4 | 3 | 2 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | SP1 CHA | 0 | 0 |
| W-Oh | W-Oh | W-Oh | W-Oh | R/W-Oh | W-Oh | W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 35. Register 139h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-4$ | 0 | W | Oh | Must write 0. |
| 3 | SP1 CHA | R/W | Oh | This bit sets the special mode for best performance on channel <br> A. <br> Always write 1 after reset. |
| $2-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.29 Register 21Dh (address = 21Dh)

Figure 79. Register 21Dh

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | HIGH IF MODE1 | 0 |
| W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | R/W-Oh | W-Oh |

LEGEND: R/W = Read/Write; $W=$ Write only; $-n=$ value after reset
Table 36. Register 21Dh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| 1 | HIGH IF MODE1 | R/W | Oh | Set all register bits belonging to HIGH IF MODE as logic HIGH <br> to improve HD3 by a couple of dB for IF $>100 \mathrm{MHz}$. |
| 0 | 0 | W | Oh | Must write 0. |

### 8.6.1.30 Register 222h (address = 222h)

Figure 80. Register 222h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | DIS CHOP CHD |
| $W-0 h$ | $W-O h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $R / W-O h$ |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; -n = value after reset
Table 37. Register 222h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| 1 | DIS CHOP CHD | R/W | Oh | This bit disables the chopper. <br> Set this bit to shift the $1 / f$ noise floor at dc. <br> $0=1 / f$ noise floor is centered at $\mathrm{f}_{\mathrm{S}} / 2$ (default) <br> (ded; Chopper mechanism is disabled; 1/f noise floor is centered <br> at dc |
| 0 | 0 | W | Oh | Must write 0. |

### 8.6.1.31 Register 234h (address = 234h)

Figure 81. Register 234h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | DIS DITH CHD | 0 | DIS DITH CHD | 0 | 0 |
| W-Oh | W-Oh | R/W-Oh | W-Oh | R/W-Oh | W-Oh | W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; -n = value after reset
Table 38. Register 234h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-6$ | 0 | W | Oh | Must write 0. |
| 5 | DIS DITH CHD | R/W | Oh | Set this bit with bits 1 and 0 of register 01h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel D. In this mode, SNR <br> typically improves by 0.2 dB at 70 MHz. |
| 4 | 0 | W | Oh | Must write 0. |
| 3 | DIS DITH CHD | R/W | Oh | Set this bit with bits 1 and 0 of register 01h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel D. In this mode, SNR <br> typically improves by 0.2 dB at 70 MHz. |
| $2-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.32 Register 239h (address = 239h)

Figure 82. Register 239h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | SP1 CHD | 0 | 0 | 0 |
| W-Oh | W-Oh | W-Oh | W-Oh | R/W-Oh | W-Oh | W-Oh | W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 39. Register 239h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-4$ | 0 | W | Oh | Must write 0. |
| 3 | SP1 CHD | R/W | Oh | This bit sets the special mode for best performance on channel <br> D. <br> Always write 1 after reset. |
| $2-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.33 Register 308h (address = 308h)

Figure 83. Register 308h

| 7 | 6 | 5 | 4 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| HIGH IF MODE<5:4> | 0 | 0 | 0 | 0 | 0 |  |
| W-Oh | W-0h | W-0h | W-0h | W-0h | W-0h | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 40. Register 308h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-6$ | HIGH IF MODE<5:4> | R/W | 0h | Set all register bits belonging to HIGH IF MODE as logic HIGH <br> to improve HD3 by a couple of dB for IF $>100$ MHz. |
| $5-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.34 Register 31Dh (address = 31Dh)

Figure 84. Register 31Dh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| HIGH IF <br> MODE4 | 0 | 0 | 0 | 0 | 0 | HIGH IF <br> MODE4 | 0 |
| R/W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | R/W-0h |  |

LEGEND: R/W = Read/Write; $W=$ Write only; $-n=$ value after reset
Table 41. Register 31Dh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | HIGH IF MODE4 | R/W | Oh | Set all register bits belonging to HIGH IF MODE as logic HIGH <br> to improve HD3 by a couple of dB for IF $>100 \mathrm{MHz}$. |
| $6-2$ | 0 | W | Oh | Must write 0. |
| 1 | HIGH IF MODE4 | R/W | Oh | Set all register bits belonging to HIGH IF MODE as logic HIGH <br> to improve HD3 by a couple of dB for IF $>100 \mathrm{MHz}$. |
| 0 | 0 | W | Oh | Must write 0. |

### 8.6.1.35 Register 41Dh (address $=41 \mathrm{Dh})$

Figure 85. Register 41Dh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | HIGH IF MODE2 |
| $W-0 h$ | $W-O h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-O h$ | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 42. Register 41Dh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| 1 | HIGH IF MODE2 | R/W | Oh | Set all register bits belonging to HIGH IF MODE as logic HIGH <br> to improve HD3 by a couple of dB for IF $>100 \mathrm{MHz}$. |
| 0 | 0 | W | Oh | Must write 0. |

### 8.6.1.36 Register 422h (address $=422 h$ )

Figure 86. Register 422h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | DIS CHOP CHB |
| $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $R / W-O h$ |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; -n = value after reset
Table 43. Register 422h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| 1 | DIS CHOP CHB | R/W | Oh | This bit disables the chopper. <br> Set this bit to shift the $1 / f$ noise floor at dc. <br> $0=1 / f$ noise floor is centered at $\mathrm{f}_{\mathrm{S}} / 2$ (default) <br> $1=$ Chopper mechanism is disabled; 1/f noise floor is centered <br> at dc |
| 0 | 0 | W | Oh | Must write 0. |

### 8.6.1.37 Register 434h (address $=434 h$ )

Figure 87. Register 434h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | DIS DITH CHB | 0 | DIS DITH CHB | 0 | 0 |
| W-Oh | W-Oh | R/W-Oh | W-Oh | R/W-Oh | W-Oh | W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 44. Register 434h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-6$ | 0 | W | Oh | Must write 0. |
| 5 | DIS DITH CHB | R/W | Oh | Set this bit with bits 5 and 4 of register 01h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel B. In this mode, SNR typically <br> improves by 0.2 dB at 70 MHz. |
| 4 | 0 | W | Oh | Must write 0. |
| 3 | DIS DITH CHB | R/W | Oh | Set this bit with bits 5 and 4 of register 01h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel B. In this mode, SNR typically <br> improves by 0.2 dB at 70 MHz. |
| $2-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.38 Register 439h (address $=439 \mathrm{~h}$ )

Figure 88. Register 439h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | SP1 CHB | 0 | 0 | 0 |
| W-Oh | W-Oh | W-Oh | W-Oh | R/W-Oh | W-Oh | W-Oh | W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 45. Register 439h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-4$ | 0 | W | Oh | Must write 0. |
| 3 | SP1 CHB | R/W | Oh | This bit sets the special mode for best performance on channel <br> B. <br> Always write 1 after reset. |
| $2-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.39 Register 51Dh (address = 51Dh)

Figure 89. Register 51Dh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | HIGH IF MODE3 |
| W-Oh | W-Oh | W-Oh | W-Oh | W-0h | W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 46. Register 51Dh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| 1 | HIGH IF MODE3 | R/W | Oh | Set all register bits belonging to HIGH IF MODE as logic HIGH <br> to improve HD3 by a couple of dB for IF > 100 MHz. |
| 0 | 0 | W | Oh | Must write 0. |

### 8.6.1.40 Register 522h (address $=522 h$ )

Figure 90. Register 522h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| W-Oh | W-Oh | W-Oh | W-Oh | W-0h | W-Oh | 0 |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 47. Register 522h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0. |
| 1 | DIS CHOP CHC | R/W | Oh | This bit disables the chopper. <br> Set this bit to shift the $1 / \mathrm{f}$ noise floor at dc. <br> $0=1 / \mathrm{f}$ noise floor is centered at $\mathrm{f}_{\mathrm{S}} / 2$ (default) <br> $1=$ Chopper mechanism is disabled; $1 / \mathrm{f}$ noise floor is centered <br> at dc |
| 0 | 0 |  | Wust write 0. |  |

### 8.6.1.41 Register 534h (address = 534h)

Figure 91. Register 534h

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | DIS DITH CHC | 0 | DIS DITH CHC | 0 | 0 | 0 |
| W-Oh | W-Oh | R/W-Oh | W-Oh | R/W-Oh | W-Oh | W-Oh | W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 48. Register 534h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-6$ | 0 | W | Oh | Must write 0. |
| 5 | DIS DITH CHC | R/W | Oh | Set this bit with bits 3 and 2 of register 01h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel C. In this mode, SNR <br> typically improves by 0.2 dB at 70 MHz. |
| 4 | 0 | W | Oh | Must write 0. |
| 3 | DIS DITH CHC | R/W | Oh | Set this bit with bits 3 and 2 of register 01 h. <br> $00=$ Default <br> $11=$ Dither is disabled for channel C. In this mode, SNR <br> typically improves by 0.2 dB at 70 MHz. |
| $2-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.42 Register 539h (address $=539 \mathrm{~h})$

Figure 92. Register 539h

| 7 | 6 | 5 | 4 | 3 | 2 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | SP1 CHC | 0 | 0 |
| W-Oh | W-Oh | W-Oh | W-Oh | R/W-Oh | W-Oh | W-Oh |

LEGEND: R/W = Read/Write; $\mathrm{W}=$ Write only; $-\mathrm{n}=$ value after reset
Table 49. Register 539h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-4$ | 0 | W | Oh | Must write 0. |
| 3 | SP1 CHC | R/W | Oh | This bit sets the special mode for best performance on channel <br> C. <br> Always write 1 after reset. |
| $2-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.43 Register 608h (address $=608 \mathrm{~h}$ )

Figure 93. Register 608h

| 7 | 6 | 4 | 3 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| HIGH IF MODE<7:6> | 0 | 0 | 0 | 0 | 0 | 0 |  |
| W-Oh | W-Oh | W-Oh | W-Oh | W-0h | W-Oh | R/W-Oh | W-Oh |

LEGEND: R/W = Read/Write; $W=$ Write only; $-n=$ value after reset
Table 50. Register 608h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-6$ | HIGH IF MODE $<7: 6>$ | R/W | Oh | Set all register bits belonging to HIGH IF MODE as logic HIGH <br> to improve HD3 by a couple of dB for IF $>100 \mathrm{MHz}$. |
| $5-0$ | 0 | W | Oh | Must write 0. |

### 8.6.1.44 Register 61Dh (address = 61Dh)

Figure 94. Register 61Dh

| 7 | 6 | 5 | 4 | 3 | 2 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| HIGH IF <br> MODE5 | 0 | 0 | 0 | 0 | 0 | HIGH IF <br> MODE5 | PDN SYSREF |
| R/W-0h | W-Oh | W-0h | W-Oh | W-Oh | W-0h | R/W-Oh |  |

LEGEND: R/W = Read/Write; $W=$ Write only; $-\mathrm{n}=$ value after reset
Table 51. Register 61Dh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | HIGH IF MODE5 | R/W | Oh | Set all register bits belonging to HIGH IF MODE as logic HIGH <br> to improve HD3 by a couple of dB for IF > 100 MHz. |
| $6-2$ | 0 | W | Oh | Must write 0. |
| 1 | HIGH IF MODE5 | R/W | Oh | Set all register bits belonging to HIGH IF MODE as logic HIGH <br> to improve HD3 by a couple of dB for IF > 100 MHz. |
| 0 | 0 | W | Oh | Must write 0. |

### 8.6.1.45 Register 70Ah (address $=70 A h$ )

Figure 95. Register 70Ah

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | PDN SYSREF |
| W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | W-Oh | R/W-Oh |

LEGEND: R/W = Read/Write; $W=$ Write only; $-n=$ value after reset
Table 52. Register 70Ah Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0. |
| 0 | PDN SYSREF | R/W | Oh | If the SYSREF pins are not used in the system, the SYSREF <br> buffer must be powered down by setting this bit. <br> $0=$ Normal operation <br> $=$ Powers down the SYSREF buffer |

### 8.6.1.46 Register 71Ah (address = 71Ah)

Figure 96. Register 71Ah

| 7 | 6 | 5 | 4 | 3 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | DC FORCE[2:0] | 0 |
| $W-0 h$ | $W-O h$ | $W-0 h$ | R/W-0h | W-0h |  |

LEGEND: R/W = Read/Write; $W=$ Write only; $-\mathrm{n}=$ value after reset
Table 53. Register 71Ah Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-4$ | 0 | W | Oh | Must write 0. |
| $3-1$ | DC FORCE[2:0] | R/W | Oh | These Bits force internal DC voltage to ADC's analog inputs <br> together for all channels. Minimum DC voltage corresponds to <br> output code 745 and max DC voltage to output code 3332 <br> typically following the equation: <br> Output Code $=368 \times$ DC FORCE[2:0] +745 |
| 0 | 0 | W | Oh | Must write 0. |

## 9 Applications and Implementation

## NOTE

Information in the following applications sections is not part of the Tl component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

Typical applications involving transformer-coupled circuits are discussed in this section. Transformers (such as ADT1-1WT or WBC1-1) can be used up to 250 MHz to achieve good phase and amplitude balances at ADC inputs. When designing the de driving circuits, the ADC input impedance must be considered. Figure 97 and Figure 98 show the impedance $\left(\mathrm{Z}_{\text {in }}=\mathrm{R}_{\text {in }} \| \mathrm{C}_{\text {in }}\right)$ across the ADC input pins.


Figure 97. Differential Input Resistance, $\mathbf{R}_{\text {IN }}$


Figure 98. Differential Input Capacitance, $\mathrm{C}_{\mathrm{IN}}$

### 9.2 Typical Applications

### 9.2.1 Driving Circuit Design: Low Input Frequencies



Figure 99. Driving Circuit for Low Input Frequencies

### 9.2.1.1 Design Requirements

For optimum performance, the analog inputs must be driven differentially. An optional $5-\Omega$ to $15-\Omega$ resistor in series with each input pin can be kept to damp out ringing caused by package parasitic. The drive circuit may have to be designed to minimize the impact of kick-back noise generated by sampling switches opening and closing inside the ADC, as well as ensuring low insertion loss over the desired frequency range and matched impedance to the source.

### 9.2.1.2 Detailed Design Procedure

A typical application involving using two back-to-back coupled transformers is illustrated in Figure 99. The circuit is optimized for low input frequencies. An external R-C-R filter using $50-\Omega$ resistors and a $22-\mathrm{pF}$ capacitor is used with the series inductor ( 39 nH ), this combination helps absorb the sampling glitches.

### 9.2.1.3 Application Curve

Figure 100 shows the performance obtained by using the circuit shown in Figure 99.

> SFDR $=95 \mathrm{dBc}, \mathrm{SNR}=71 \mathrm{dBFS}, \mathrm{SINAD}=71 \mathrm{dBFS}$, THD $=94 \mathrm{dBc}, \mathrm{HD} 2=106 \mathrm{dBc}, \mathrm{HD} 3=95 \mathrm{dBc}$

Figure 100. Performance FFT at 10 MHz (Low Input Frequency)

ADC3421-Q1
SBAS958A -DECEMBER 2019-REVISED JUNE 2020

## Typical Applications (continued)

### 9.2.2 Driving Circuit Design: Input Frequencies Between 100 MHz to 230 MHz



Figure 101. Driving Circuit for Mid-Range Input Frequencies ( $100 \mathbf{~ M H z}<\mathrm{f}_{\mathrm{IN}}<\mathbf{2 3 0} \mathbf{~ M H z}$ )

### 9.2.2.1 Design Requirements

See the Design Requirements section for further details.

### 9.2.2.2 Detailed Design Procedure

When input frequencies are between 100 MHz to 230 MHz , an R-LC-R circuit can be used to optimize performance, as shown in Figure 101.

### 9.2.2.3 Application Curve

Figure 102 shows the performance obtained by using the circuit shown in Figure 101.


SFDR $=87 \mathrm{dBc}, \mathrm{SNR}=69.8 \mathrm{dBFS}, \operatorname{SINAD}=69.7 \mathrm{dBFS}$,
THD $=85 \mathrm{dBc}, \mathrm{HD} 2=90 \mathrm{dBc}, \mathrm{HD} 3=87 \mathrm{dBc}$

$$
\mathrm{THD}=85 \mathrm{dBc}, \mathrm{HD} 2=90 \mathrm{dBc}, \mathrm{HD} 3=87 \mathrm{dBc}
$$

Figure 102. Performance FFT at 170 MHz (Mid Input Frequency)

## Typical Applications (continued)

### 9.2.3 Driving Circuit Design: Input Frequencies Greater than $230 \mathbf{M H z}$



Figure 103. Driving Circuit for High Input Frequencies ( $\mathrm{f}_{\mathrm{N}} \mathbf{>} \mathbf{2 3 0} \mathbf{~ M H z}$ )

### 9.2.3.1 Design Requirements

See the Design Requirements section for further details.

### 9.2.3.2 Detailed Design Procedure

For high input frequencies (> 230 MHz ), using the R-C-R or R-LC-R circuit does not show significant improvement in performance. However, a series resistance of $10 \Omega$ can be used as shown in Figure 103.

### 9.2.3.3 Application Curve

Figure 104 shows the performance obtained by using the circuit shown in Figure 103.


Figure 104. Performance FFT at 450 MHz (High Input Frequency)

## 10 Power Supply Recommendations

The device requires a $1.8-\mathrm{V}$ nominal supply for AVDD and DVDD. There are no specific sequence power-supply requirements during device power-up. AVDD and DVDD can power up in any order.

## 11 Layout

### 11.1 Layout Guidelines

The ADC3421-Q1 EVM layout can be used as a reference layout to obtain the best performance. A layout diagram of the EVM top layer is provided in Figure 105. Some important points to remember during laying out the board are:

1. Analog inputs are located on opposite sides of the device pin out to ensure minimum crosstalk on the package level. To minimize crosstalk onboard, the analog inputs must exit the pin out in opposite directions, as shown in the reference layout of Figure 105 as much as possible.
2. In the device pin out, the sampling clock is located on a side perpendicular to the analog inputs in order to minimize coupling between them. This configuration is also maintained on the reference layout of Figure 105 as much as possible.
3. Keep digital outputs away from the analog inputs. When these digital outputs exit the pin out, the digital output traces must not be kept parallel to the analog input traces because this configuration can result in coupling from digital outputs to analog inputs and degrade performance. All digital output traces to the receiver [such as a field-programmable gate array (FPGA) or an application-specific integrated circuit (ASIC)] must be matched in length to avoid skew among outputs.
4. At each power-supply pin (AVDD and DVDD), keep a $0.1-\mu \mathrm{F}$ decoupling capacitor close to the device. A separate decoupling capacitor group consisting of a parallel combination of $10-\mu \mathrm{F}$, 1- $\mu \mathrm{F}$, and $0.1-\mu \mathrm{F}$ capacitors can be kept close to the supply source.

### 11.2 Layout Example



Figure 105. Typical Layout of the ADC3421-Q1 Board

## 12 Device and Documentation Support

### 12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on Alert me to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 12.2 Support Resources

TI E2E ${ }^{T M}$ support forums are an engineer's go-to source for fast, verified answers and design help - straight from the experts. Search existing answers or ask your own question to get the quick design help you need.
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### 12.3 Trademarks

E2E is a trademark of Texas Instruments.
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### 12.4 Electrostatic Discharge Caution

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 12.5 Glossary

SLYZ022 - TI Glossary.
This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

INSTRUMENTS

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead finish/ Ball material <br> (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD3421QRWERQ1 | ACTIVE | VQFNP | RWE | 56 | 2000 | RoHS \& Green | NIPDAUAG | Level-3-260C-168 HR | -40 to 125 | AZ3421Q | Samples |
| AD3421QRWETQ1 | ACTIVE | VQFNP | RWE | 56 | 250 | RoHS \& Green | NIPDAUAG | Level-3-260C-168 HR | -40 to 125 | AZ3421Q | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption
Green: TI defines "Green" to mean the content of Chlorine ( Cl ) and Bromine ( Br ) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the $<=1000 \mathrm{ppm}$ threshold requirement
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a " $\sim$ " will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF ADC3421-Q1 :

- Catalog : ADC3421

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

TeXAS

TAPE AND REEL INFORMATION

*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> $\mathbf{W 1}(\mathbf{m m})$ | A0 <br> $(\mathbf{m m})$ | B0 <br> $(\mathbf{m m})$ | K0 <br> $(\mathbf{m m})$ | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD3421QRWERQ1 | VQFNP | RWE | 56 | 2000 | 330.0 | 16.4 | 8.3 | 8.3 | 2.25 | 12.0 | 16.0 | Q2 |

PACKAGE MATERIALS INFORMATION

*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD3421QRWERQ1 | VQFNP | RWE | 56 | 2000 | 350.0 | 350.0 | 43.0 |



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

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